

XC9110/XC9111 Series

ETR0406 004

PFM Controlled Step-Up DC/DC Converter / Controller ICs

GENERAL DESCRIPTION

The XC9110/9111 series is a group of PFM controlled step-up DC/DC converter/controller ICs designed to generate low supply voltage by the combination of PFM control and CMOS structure. The series is ideal for applications where a longer battery life is needed such as in portable communication equipment. With a built-in 2.5 N-channel driver transistor, the XC9110A/C/E and XC9111A/C/E types provide a step-up operation by using only a coil, a capacitor, and a diode connected externally. The XC9110/9111B, D and F versions can be used with an external transistor for applications requiring larger currents.

Output voltage is internally programmable in a range from 1.5V to 7.0V in increments of 0.1V (accuracy: $\pm 2.5\%$).

Maximum oscillation frequency is set to 100kHz for XC9110/9111 series. (At light loads, it is set to 180kHz for the XC9111 series.) Options include products equipped with a CE pin (C and D versions) that allows the IC to be shut down thereby reducing supply current and with separated V_{DD}/V_{OUT} pins (E and F versions) to separate the power supply block and the output voltage detect block. With the XC9110 series, maximum duty cycle is set to 75% ($V_{DD}=3.3V$) making it suitable for use with large current operations. The XC9111 series automatically switches duty ratio between 56% & 75% ($V_{DD}=3.3V$) when it senses changes in load to drop output ripple voltage and can support both large and small currents. The external transistor types (B/D/F types) can be provided for applications, which require larger currents.

APPLICATIONS

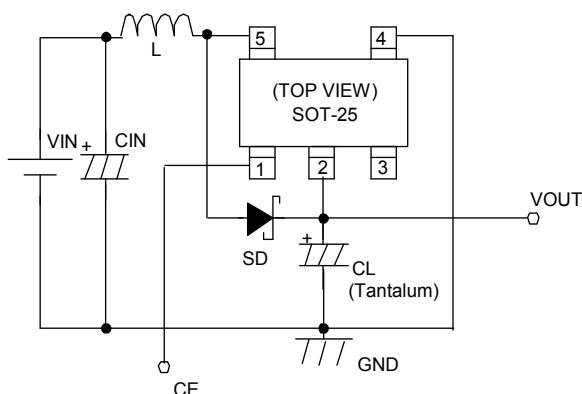
Mobile phones
Various palm top equipment
Cameras, VCRs
Various portable equipment

FEATURES

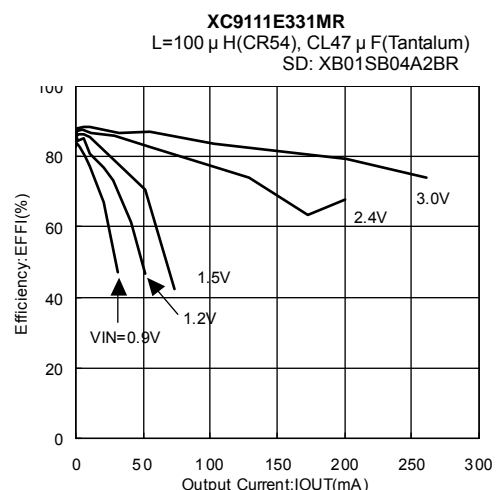
- Operating (Input) Voltage Range** : 0.9V ~ 10.0V
- Output Voltage Range** : 1.5V~7.0V
(0.1V increments, accuracy $\pm 2.5\%$)
- Maximum Oscillation Frequency**
: 100kHz (accuracy $\pm 15\%$)
180kHz (for the XC9111 series, duty ratio: 56% at light loads)
- Built-in Switching N-ch Transistor**
: A/C/E type
ON Resistance 2.5 ($V_{DD}=3.0V$)
- External Transistor Types** : B/D/F type
- Lx Limit Voltage** : E type: more than $V_{DD}=2.0V$
: A/C type: more than $V_{OUT}=2.0V$
- Low Supply Current** : 2.0 μA
(When operating, $V_{OUT}=3V$)
- Small Package** : SOT-23 & SOT89
(for XC9111 series),
SOT-25, USP-6C

TYPICAL APPLICATION CIRCUIT

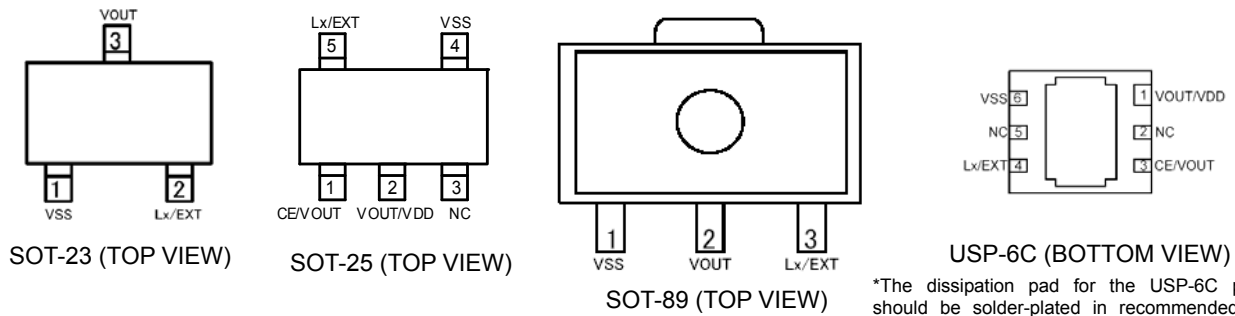
C type circuit



TYPICAL PERFORMANCE CHARACTERISTICS



PIN CONFIGURATION



*The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the pin No.1.

PIN ASSIGNMENT

XC9111A/B

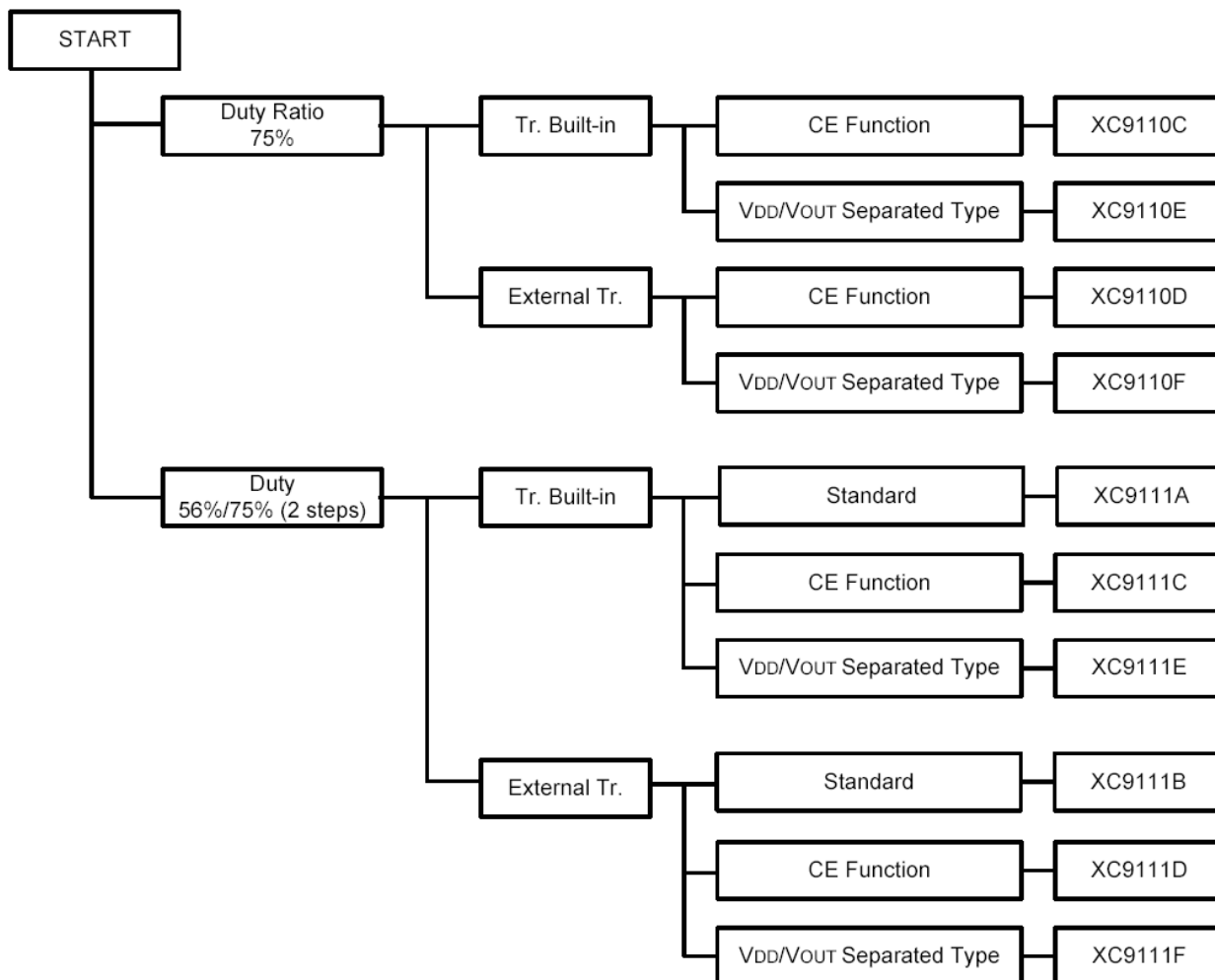
PIN NUMBER				PIN NAME	FUNCTIONS
SOT-23		SOT-89			
A	B	A	B		
1	1	1	1	VSS	: Ground
3	3	2	2	VOUT	: Output Voltage Monitor, Internal Power Supply
2	-	3	-	LX	: Switch
-	2	-	3	EXT	: External Switching transistor drive <N-ch transistor drive>

●XC9110//9111C/D/E/F

PIN NUMBER								PIN NAME	FUNCTIONS
SOT-25				USP-6C					
C	D	E	F	C	D	E	F		
-	-	2	2	-	-	1	1	VDD	Internal Power Supply
4	4	4	4	6	6	6	6	VSS	Ground
-	5	-	5	-	4	-	4	EXT	External switching transistor drive <Connect to the gate pin of N-ch Power MOSFET>
5	-	5	-	4	-	4	-	Lx	Switch
1	1	-	-	3	3	-	-	CE	Chip Enable <Connect to the VOUT pin when Active and the VSS pin when stand-by>
2	2	1	1	1	1	3	3	VOUT	Output voltage monitor
3	3	3	3	2,5	2,5	2,5	2,5	NC	No connection

PRODUCT CLASSIFICATION

Selection Guide



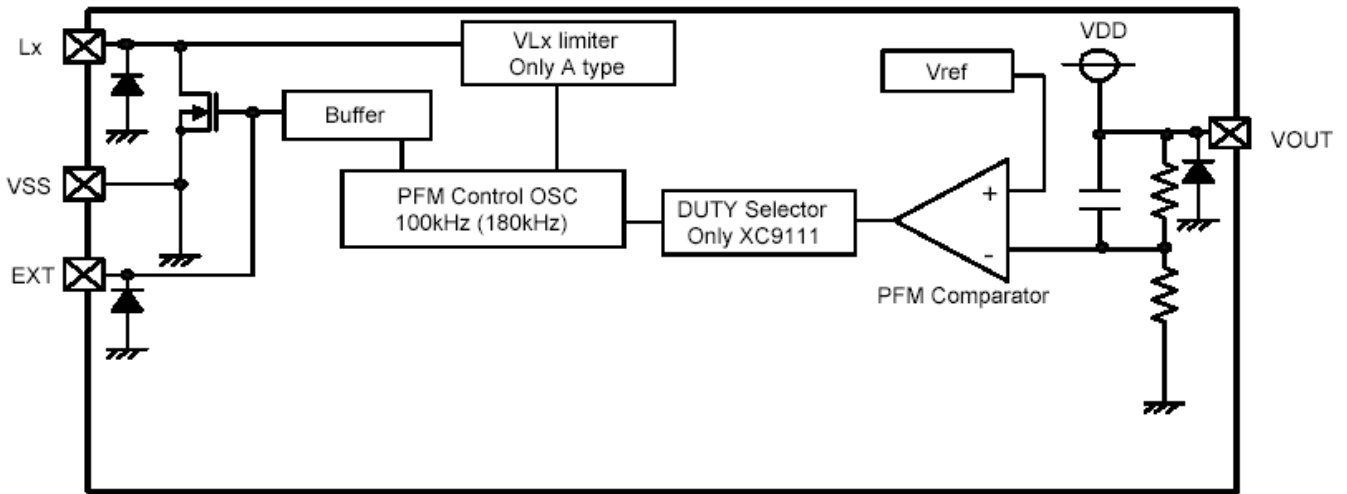
Ordering Information

XC9110 : PFM control, 75% duty
 XC9111 : PFM control, 56% / 75% duty variable

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
	CE Function	A	: VDD / VOUT common type (for XC9111series) Built-in Transistor
		B	: VDD / VOUT common type (for XC9111series) External Transistor
		C	: CE pin (5 pin) Built-in Transistor
		D	: CE pin (5 pin) External Transistor
		E	: VDD / VOUT separated type (5 pin) Built-in Transistor
		F	: VDD / VOUT separated type (5 pin) External Transistor
	Output Voltage	15 ~ 70	: ex. 3.5V output = 3, = 5
	Maximum Oscillation Frequency	1	: 100kHz
	Package	M	: SOT-23 (for A and B types) Semi-Custom
			: SOT-25 (for C, D, F types)
		P	: SOT-89 (for A and B types) Semi-Custom
		E	: USP-6C (for C, D, F types)
	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed

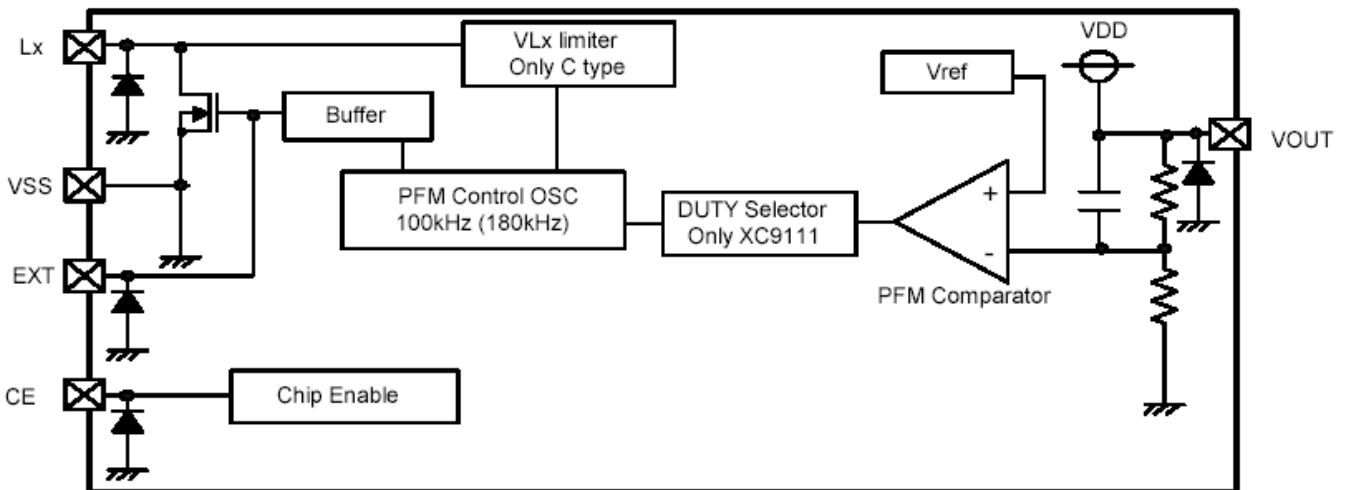
BLOCK DIAGRAMS

XC9111 A and B series



Note: The XC9110 series, Tr. Built-in type, uses the Lx pin and the XC9111 series, external Tr. Type, uses the EXT pin. The duty ratio of the XC9111 series automatically varies between 56% (oscillation frequency 180kHz) and 75% (oscillation frequency (f_{osc}) 100kHz). The VLx limit function only applies to the XC9110/9111 A types.
 * The duty ratio depends on power supply. Please refer to the electrical characteristics on duty against output voltage you use.

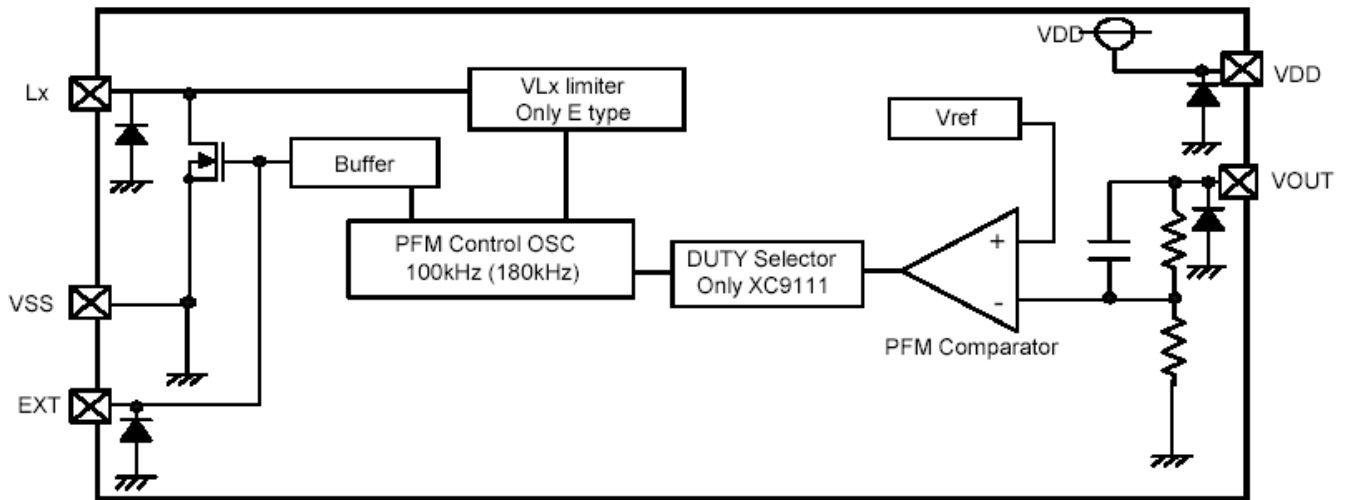
XC9110 / 9111 C and D series



Note: The XC9110 series, Tr. Built-in type, uses the Lx pin and the XC9111 series, external Tr. Type, uses the EXT pin. The XC9110 series' duty ratio is 75% and oscillation frequency (f_{osc}) is 100kHz. The duty ratio of the XC9111 series automatically varies between 56% (oscillation frequency 180kHz) and 75% (oscillation frequency (f_{osc}) 100kHz). The VLx limit function only applies to the XC9110/9111 C versions.
 * The duty ratio depends on power supply. Please refer to the electrical characteristics on duty against output voltage you use.

BLOCK DIAGRAMS

XC9111 E and F series



Note: The XC9110 series, Tr. Built-in type, uses the Lx pin and the XC9111 series, external Tr. Type, uses the EXT pin. The XC9110 / 9111 series E and F series have the VDD pin. The XC9110 series' duty ratio is 75% and oscillation frequency (f_{osc}) is 100kHz. The duty ratio of the XC9111 series automatically varies between 56% (oscillation frequency 180kHz) and 75% (oscillation frequency (f_{osc}) 100kHz). The VLx limit function only applies to the XC9110/9111 C versions.

* The duty ratio depends on power supply.

Please refer to the electrical characteristics on duty against output voltage you use.

ABSOLUTE MAXIMUM RATINGS

Ta = 25

PARAMETER	SYMBOL	RATINGS	UNITS
VOUT Input Voltage	VOUT	- 0.3 ~ 12.0	V
Lx Pin Voltage	VLx	- 0.3 ~ 12.0	V
Lx Pin Current	ILx	400	mA
EXT Pin Voltage	VEXT	VSS - 0.3 ~ VOUT + 0.3	V
EXT Pin Current	IEXT	± 100	mA
CE Input Voltage	VCE	- 0.3 ~ 12.0	V
VDD Input Voltage	VDD	- 0.3 ~ 12.0	V
Power Dissipation	SOT-23, 25	250	mW
	SOT-89	500	
	USP-6C	100	
Operating Temperature Range	Topr	- 40 ~ + 85	
Storage Temperature Range	Tstg	- 55 ~ +125	

* Define as Vss with a standard of all the voltage.

ELECTRICAL CHARACTERISTICS

XC9111Axx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connected to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot T_{opr}}$	Connected to external components - 40 Topr 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	
Operating Start Voltage	V _{ST1}	I _{OUT} =1mA, Connected to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT} , V _{pull} =1.0V	-	-	0.8	V	
Operating Hold Voltage	V _{HLD}	I _{OUT} =1mA, Connected to external components	0.7	-	-	V	
Input Current at No Load	I _{IN}	I _{OUT} =0mA (*1)	-	E1-1(*)	E1-2(*)	μA	
Supply Current 1 (*2)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μA	
Supply Current 2	I _{DD2}	Applied (output voltage+0.5) to V _{OUT}	-	E3-1(*)	E3-2(*)	μA	
Lx Switch ON Resistance	R _{SWON}	Same as I _{DD1} , V _{Lx} =0.4V (*3)	-	E4-1(*)	E4-2(*)		
Lx Leak Current	I _{LxL}	Same as I _{DD2} , V _{Lx} = 7V	-	-	1	μA	
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time. Connect to external components	48	56	64	%	
Maximum Oscillation Frequency	MAX _{f_{OSC}}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation Frequency 2	MAX _{f_{OSC2}}	Same as I _{DD1}	153	180	207	kHz	
Lx Limit Voltage (*4)	V _{LxLMT}	Same as I _{DD1} , V _{Lx} when max. oscillation frequency is more than double	0.7	-	1.1	V	
Efficiency (*5)	EFFI	Connect to external components	-	E8(*)	-	%	

Test condition : Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>, V_{pull}=5.0V

NOTE:

- *1: TOREX SBD, XB01SB04A2BR is used, reverse current IR < 1 μA (when reverse voltage V_R = 10V is applied), in case of using selected parts.
- *2: Supply Current 1 is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption. Please refer to Input Current (I_{IN}) under no load condition for the actual current, which is supplied from the input power supply (V_{IN}).
- *3: Lx switch ON resistance can be calculated by (V_{Lx} × R_p) / (V_{pull} - V_{Lx}). * Change V_{pull} so that V_{Lx} will become 0.4V.
- *4: The Lx limit voltage function becomes stable when V_{OUT} is over 2.0V.
- *5: EFFI=[{output voltage} × (output current)] / [(input voltage) × (input current)] × 100
- *6: Please be aware of the absolute maximum ratings of the external components.
- (*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

XC9111Bxx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connected to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot T_{opr}}$	Connected to external components - 40 T _{opr} 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	-
Operating Start Voltage	V _{ST1}	I _{OUT} =1mA, Connected to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT}	-	-	0.8	V	
Operation Hold Voltage	V _{HLD}	I _{OUT} =1mA, Connected to external components	0.7	-	-	V	
Supply Current 1 (*1)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μ A	
Supply Current 2	I _{DD2}	Applied (output voltage+0.5) to V _{OUT}	-	E3-1(*)	E3-2(*)	μ A	
EXT 'H' ON Resistance	R _{EXTH}	Same as I _{DD1} , V _{EXT} =V _{OUT} -0.4V (*2)	-	E5-1(*)	E5-2(*)		
EXT 'L' ON Resistance	R _{EXTL}	Same as I _{DD1} , V _{EXT} =0.4V (*3)	-	E6-1(*)	E6-2(*)		
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time. Connect to external components	48	56	64	%	
Maximum Oscillation Frequency	MAX _{f_{OSC}}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation Frequency 2	MAX _{f_{OSC2}}	Same as I _{DD1}	153	180	207	kHz	
Efficiency (*4)	EFFI	Connect to external components	-	E9(*)	-	%	

Test condition : Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>

NOTE:

*1: Supply Current 1 is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption.

*2: EXT 'H' ON resistance can be calculated by $(0.4 \times R_p) / (V_{EXT} - V_{pull})$. * Change V_{pull} so that V_{EXT} will become V_{OUT}-0.4V.

*3: EXT 'L' ON resistance can be calculated by $(V_{EXT} \times R_p) / (V_{pull} - V_{EXT})$. * Change V_{pull} so that V_{EXT} will become 0.4V.

*4: EFFI={ [output voltage] × (output current) } / [(input voltage) × (input current)] × 100

*5: Please be aware of the absolute maximum ratings of the external components.

(*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

XC9110Cxx1MR, XC9111Cxx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connect to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot \text{topr}}$	Connect to external components - 40 Topr 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	
Operation Start Voltage	V _{ST1}	I _{OUT} =1mA, connect to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT} , V _{pull} =1.0V	-	-	0.8	V	
Operation Hold Voltage	V _{HLD}	I _{OUT} =1mA, connect to external components	0.7	-	-	V	
Input Current	I _{IN}	I _{OUT} =0mA (*1)	-	E1-1(*)	E1-2(*)	μA	
Supply Current 1 (*2)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μA	
Supply Current 2	I _{DD2}	Applied (output voltage + 0.5V) to V _{OUT}	-	E3-1(*)	E3-2(*)	μA	
Lx Switch ON Resistance	R _{SWON}	Same as I _{DD1} , V _{Lx} =0.4V (*3)	-	E4-1(*)	E4-2(*)		
Lx Leak Current	I _{LxL}	Same as I _{DD2} , V _{Lx} =7V	-	-	1	μA	
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time (XC9111 only) Connect to external components	48	56	64	%	
Maximum Oscillation Frequency	MAXf _{OSC}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation Frequency 2	MAXf _{OSC2}	Same as I _{DD1} (XC9111 only)	153	180	207	kHz	
Stand-by Current	I _{STB}	Same as I _{DD1} , V _{CE} =0V	-	-	0.50	μA	
CE "High" Voltage	V _{CEH}	Same as I _{DD1} , determine Lx oscillation	0.75	-	-	V	
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} , determine Lx shut-down	-	-	0.20	V	
CE "High" Current	I _{CEH}	Same as I _{DD1} , V _{CE} =V _{OUT} × 0.95	-	-	0.25	μA	
CE "Low" Current	I _{CEL}	Same as I _{DD1} , V _{CE} =0V	-	-	-0.25	μA	
Lx Limit Voltage (*4)	V _{LxLMT}	Same as I _{DD1} , when max. oscillation frequency is more than double.	0.7	-	1.1	V	
Efficiency (*5)	EFFI	Connect to external components	-	E8(*)	-	%	

Test condition : Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>, V_{pull}=5.0V

NOTE:

*1: TOREX SD, XB01SB04A2BR is used, reverse current I_R < 1 μA (when reverse voltage V_R = 10V is applied), in case of using selected parts.

*2: Supply Current 1 is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption. Please refer to Input Current (I_{IN}) under no load condition for the actual current, which is supplied from the input power supply (V_{IN}).

*3: Lx switch ON resistance can be calculated by (V_{Lx} × R_p) / (V_{pull} - V_{Lx}). * Change V_{pull} so that V_{Lx} will become 0.4V.

*4: The Lx. limit voltage function becomes stable when V_{OUT} of the XC9110/9111 series is over 2.0V.

*5: EFFI={([output voltage] × [output current]) / ([input voltage] × [input current])} × 100

*6: Please be aware of the absolute maximum ratings of the external components.

(*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

XC9110Dxx1MR, XC9111Dxx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connect to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot T_{opr}}$	Connect to external components - 40 T _{opr} 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	-
Operation Start Voltage	V _{ST1}	I _{OUT} =1mA, connect to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT}	-	-	0.8	V	
Operation Hold Voltage	V _{HLD}	I _{OUT} =1mA, connect to external components	0.7	-	-	V	
Supply Current 1 (*1)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μA	
Supply Current 2	I _{DD2}	Applied (output voltage + 0.5V) to V _{OUT}	-	E3-1(*)	E3-2(*)	μA	
EXT H ON Resistance	R _{EXTH}	Same as I _{DD1} , V _{EXT} =V _{OUT} -0.4(*2)	-	E5-1(*)	E5-2(*)		
EXT L ON Resistance	R _{EXTL}	Same as I _{DD1} , V _{EXT} =0.4V(*3)	-	E6-1(*)	E6-2(*)		
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time (XC9111 only) Connect to external components	48	56	64	%	
Maximum Oscillation	MAX _{f_{OSC}}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation	MAX _{f_{OSC2}}	Same as I _{DD1} (XC9111 only)	153	180	207	kHz	
Standby Current	I _{STB}	Same as I _{DD1} , V _{CE} =0V	-	-	0.50	μA	
CE "High" Voltage	V _{CEH}	Same as I _{DD1} , determine Lx oscillation	0.75	-	-	V	
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} , determine Lx shut-down	-	-	0.20	V	
CE "High" Current	I _{CEH}	Same as I _{DD1} , V _{CE} =V _{OUT} × 0.95	-	-	0.25	μA	
CE "Low" Current	I _{CEL}	Same as I _{DD1} , V _{CE} =0V	-	-	-0.25	μA	
Efficiency (*4)	EFFI	Connect to external components	-	E8(*)	-	%	

Test condition : Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>

NOTE:

- *1: "Supply Current 1" is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption.
- *2: EXT H ON resistance can be calculated by $(0.4 \times R_p) / (V_{EXT} - V_{pull})$. * Change V_{pull} so that V_{EXT} will become V_{OUT}-0.4V.
- *3: EXT L ON resistance can be calculated by $(V_{EXT} \times R_p) / (V_{pull} - V_{EXT})$. * Change V_{pull} so that V_{EXT} will become 0.4V.
- *4: EFFI={ [output voltage] × (output current) } / [(input voltage) × (input current)] × 100
- *5: Please be aware of the absolute maximum ratings of the external components.
- (*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

XC9110Exx1MR, XC9111Exx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connect to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot T_{opr}}$	Connect to external components - 40 T _{opr} 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	-
Operation Start Voltage	V _{ST1}	I _{OUT} =1mA, connect to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT} , V _{PULL} =1.0V	-	-	0.8	V	
Operation Hold Voltage	V _{HLD}	I _{OUT} =1mA, connect to external components	0.7	-	-	V	
Input Current	I _{IN}	I _{OUT} =0mA (*1)	-	E1-1(*)	E1-2(*)	μA	
Supply Current 1 (*2)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μA	
Supply Current 2	I _{DD2}	Applied (output voltage + 0.5V) to V _{OUT}	-	E3-1(*)	E3-2(*)	μA	
Lx Switch ON Resistance	R _{SWON}	Same as I _{DD1} , V _{LX} =0.4V (*3)	-	E4-1(*)	E4-2(*)		
Lx Leak Current	I _{LXL}	Same as I _{DD2} , V _{LX} =7V	-	-	1	μA	
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time (XC9111 only) Connect to external components	48	56	64	%	
Maximum Oscillation	MAX _{fOSC}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation	MAX _{fOSC2}	Same as I _{DD1} (XC9111 only)	153	180	207	kHz	
Lx Limit Voltage (*4)	V _{LXLMT}	Same as I _{DD1} , V _{LX} when max. oscillation frequency is more than double.	0.7	-	1.1	V	
Efficiency (*5)	EFFI	Connect to external components	-	E8(*)	-	%	

Test condition : Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>, V_{PULL}=5.0V

NOTE:

- *1: TOREX SD, XB01SB04A2BR is used; reverse current I_R < 1 μA (when reverse voltage V_R = 10V is applied), in case of using selected parts.
 - *2: "Supply Current 1" is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption. Please refer to Input Current (I_{IN}) under no load condition for the actual current, which is supplied from the input power supply (V_{IN}).
 - *3: Lx switch ON resistance can be calculated by (V_{LX} × R_p) / (V_{PULL} - V_{LX}). * Change V_{PULL} so that V_{LX} will become 0.4V.
 - *4: The Lx limit voltage function becomes stable when V_{OUT} of the XC9110/9111 series is over 2.0V.
 - *5: EFFI={ [output voltage] × (output current) } / [(input voltage) × (input current)] × 100
 - *6: When using V_{DD} and V_{OUT} separately, please set the voltage range of V_{DD} from 1.5V to 10V.
The IC operates from V_{DD}=0.8V, but output voltage and oscillation frequency will be stable when V_{DD}=1.5V or more.
 - *7: Please be aware of the absolute maximum ratings of the external components.
- (*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

XC9110Fxx1MR, XC9111Fxx1MR

Ta = 25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	CIRCUIT
Output Voltage	V _{OUT}	Connect to external components	× 0.975	V _{OUT}	× 1.025	V	
Output Voltage Temperature Characteristics	$\frac{V_{OUT}}{V_{OUT} \cdot t_{opr}}$	Connect to external components - 40 Topr 85	-	± 100	-	ppm/	
Maximum Input Voltage	V _{IN}		10	-	-	V	-
Operation Start Voltage	V _{ST1}	I _{OUT} =1mA, connect to external components	-	0.8	0.9	V	
Oscillation Start Voltage	V _{ST2}	Applied 0.8V to V _{OUT}	-	-	0.8	V	
Operation Hold Voltage	V _{HLD}	I _{OUT} =1mA, connect to external components	0.7	-	-	V	
Supply Current 1 (*1)	I _{DD1}	Applied (output voltage × 0.95) to V _{OUT}	-	E2-1(*)	E2-2(*)	μ A	
Supply Current 2	I _{DD2}	Applied (output voltage + 0.5V) to V _{OUT}	-	E3-1(*)	E3-2(*)	μ A	
EXT H ON Resistance	R _{EXTH}	Same as I _{DD1} , V _{EXT} =V _{OUT} -0.4V (*2)	-	E5-1(*)	E5-2(*)		
EXT L ON Resistance	R _{EXTL}	Same as I _{DD1} , V _{EXT} =0.4V (*3)	-	E6-1(*)	E6-2(*)		
Duty Ratio	DTY	Same as I _{DD1} , measure Lx waveform	E7-1(*)	E7-2(*)	E7-3(*)	%	
Duty Ratio 2	DTY2	I _{OUT} =1mA, measure Lx ON time (XC9111 only) Connect to external	48	56	64	%	
Maximum Oscillation	MAX _{f_{OSC}}	Same as I _{DD1}	85	100	115	kHz	
Maximum Oscillation	MAX _{f_{OSC2}}	Same as I _{DD1} (XC9111 only)	153	180	207	kHz	
Efficiency (*4)	EFFI	Connect to external components	-	E9(*)	-	%	

Test condition : Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=<C1(*)>

NOTE:

*1: "Supply Current 1" is the value when the IC is constantly switching. In actual operation, the oscillator periodically switches, resulting in lower power consumption.

*2: EXT H ON resistance can be calculated by $(0.4 \times R_p) / (V_{EXT} - V_{pull})$. * Change V_{pull} so that V_{EXT} will become V_{OUT}-0.4V.

*3: EXT L ON resistance can be calculated by $(V_{EXT} \times R_p) / (V_{pull} - V_{EXT})$. * Change V_{pull} so that V_{EXT} will become 0.4V.

*4: $EFFI = \{ [output\ voltage] \times [output\ current] \} / \{ [input\ voltage] \times [input\ current] \} \times 100$

*5: When using V_{DD} and V_{OUT} separately, please set the voltage range of V_{DD} from 1.5V to 10V.

The IC operates from V_{DD}=0.8V, but output voltage and oscillation frequency will be stable when V_{DD}=1.5V or more.

*6: Please be aware of the absolute maximum ratings of the external components.

(*): Please refer to the charts.

ELECTRICAL CHARACTERISTICS (Continued)

IDD2, REXTH, REXTL, DTY Chart

SYMBOL	E2-1	E2-2	E1-1	E1-2	E3-1	E3-2	E4-1	E4-2	E5-1	E5-2	E6-1	E6-2
PARAMETER	Supply Current 1		Input Current (No Load)		Supply Current 2		Lx Switch ON Resistance		EXT H ON Resistance		EXT L ON Resistance	
UNIT	(μA)		(μA)		(μA)		()		()		()	
SETTING VOLTAGE	IDD1		IIN		IDD2		RSWON		REXTH		REXTL	
	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.
1.5	7.7	15.1	4.3	8.6	1.9	3.5	4.2	6.3	160	240	67	101
1.6	8.0	15.6										
1.7	8.3	16.2										
1.8	8.6	16.8										
1.9	8.9	17.5										
2.0	9.3	18.2										
2.1	9.7	18.9	4.4	8.8	2.0	4.0	3.2	4.8	91	137	45	68
2.2	10.1	19.7										
2.3	10.5	20.6										
2.4	11.0	21.5										
2.5	11.5	22.5										
2.6	12.0	23.5										
2.7	12.5	24.5	4.6	9.3	2.1	4.2	2.8	4.2	70	105	38	57
2.8	13.1	25.6										
2.9	13.7	26.8										
3.0	14.3	28.0										
3.1	15.0	29.3										
3.2	15.7	30.6										
3.3	16.4	31.9	4.7	9.5	2.2	4.3	2.5	3.8	59	89	33	50
3.4	17.1	33.3										
3.5	17.8	34.8										
3.6	18.6	36.3										
3.7	19.4	37.9										
3.8	20.3	39.5										
3.9	21.1	41.1	5.0	10.0	2.3	4.4	2.1	3.2	40	60	24	36
4.0	22.0	42.8										
4.1	22.9	44.5										
4.2	23.8	46.3										
4.3	24.8	48.2										
4.4	25.7	50.0										
4.5	26.7	52.0	5.1	10.2	2.4	4.5	2.1	3.2	40	60	24	36
4.6	27.7	53.9										
4.7	28.8	56.0										
4.8	29.8	58.0										
4.9	30.9	60.1										
5.0	31.7	63.4										
5.1	32.3	64.7	5.2	10.4	2.5	4.6	2.1	3.2	40	60	24	36
5.2	32.9	65.9										
5.3	33.5	67.1										
5.4	34.1	68.3										
5.5	34.7	69.5										
5.6	35.3	70.7										
5.7	36.0	72.0	5.3	10.6	2.6	4.7	2.1	3.2	40	60	24	36
5.8	36.5	73.1										
5.9	37.1	74.3										
6.0	37.7	75.5										
6.1	38.4	76.8										
6.2	38.9	77.9										
6.3	39.5	79.1	5.4	10.8	2.7	4.8	2.1	3.2	40	60	24	36
6.4	40.2	80.4										
6.5	40.8	81.6										
6.6	41.3	82.7										
6.7	42.0	84.0										
6.8	42.6	85.2										
6.9	43.2	86.4										
7.0	43.7	87.5										

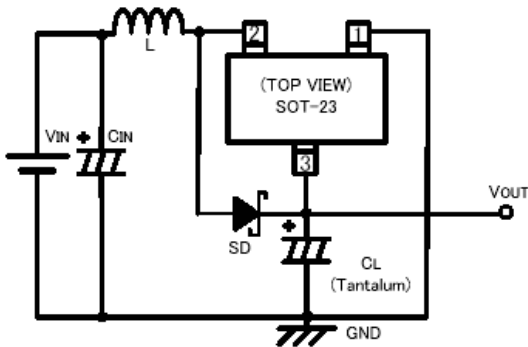
ELECTRICAL CHARACTERISTICS (Continued)

I_{OUT}, DTY, EFFI Chart

SYMBOL	C1	E7-1	E7-2	E7-3	E8		E9	
					EFFICIENCY			
PARAMETER	OUTPUT CURRENT	DUTY RATIO			XC9110	XC9111	XC9110	XC9111
UNIT	(mA)	DUTY RATIO (%)			EFFICIENCY (%)			
SETTING VOLTAGE	I _{OUT}	DTY			EFFI			
		MIN.	TYP.	MAX.	TYP.			
1.5	7.5	70	75	80	60	75	60	75
1.6	8.0							
1.7	8.5							
1.8	9.0							
1.9	9.5							
2.0	10.0							
2.1	10.5							
2.2	11.0							
2.3	11.5							
2.4	12.0							
2.5	12.5							
2.6	13.0							
2.7	13.5							
2.8	14.0							
2.9	14.5							
3.0	30.0							
3.1	31.0							
3.2	32.0							
3.3	33.0							
3.4	34.0							
3.5	35.0							
3.6	36.0							
3.7	37.0							
3.8	38.0							
3.9	39.0							
4.0	40.0							
4.1	41.0							
4.2	42.0							
4.3	43.0							
4.4	44.0							
4.5	45.0							
4.6	46.0							
4.7	47.0							
4.8	48.0							
4.9	49.0							
5.0	50.0							
5.1	51.0							
5.2	52.0							
5.3	53.0							
5.4	54.0							
5.5	55.0							
5.6	56.0							
5.7	57.0							
5.8	58.0							
5.9	59.0							
6.0	60.0							
6.1	61.0							
6.2	62.0							
6.3	63.0							
6.4	64.0							
6.5	65.0							
6.6	66.0							
6.7	67.0							
6.8	68.0							
6.9	69.0							
7.0	70.0							

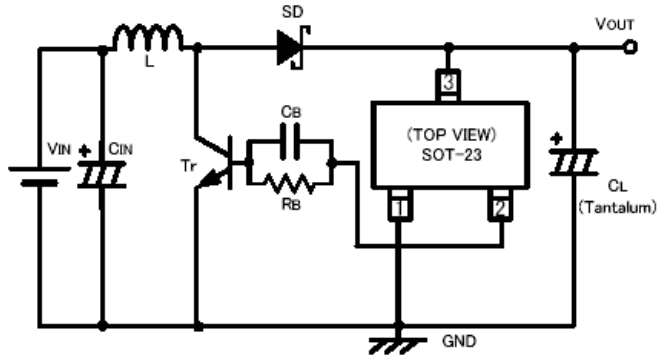
TYPICAL APPLICATION CIRCUITS

A type circuit



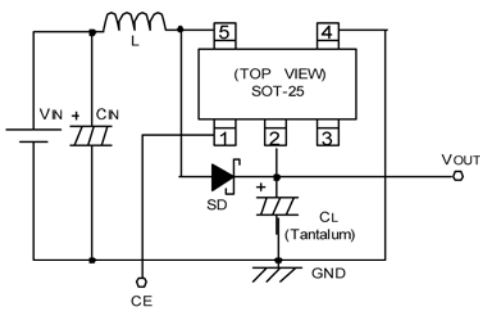
- L: 100 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)

B type circuit



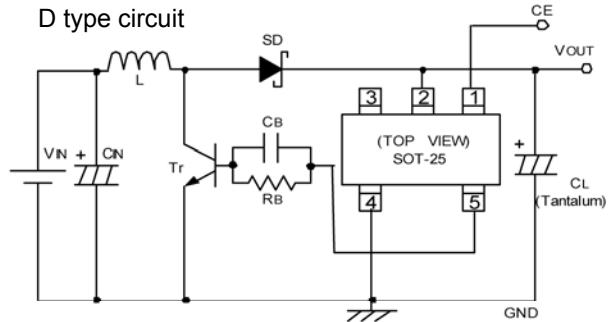
- L: 47 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)
- RB: 500
- CB: 2200pF
- Tr: 2SD1628

C type circuit



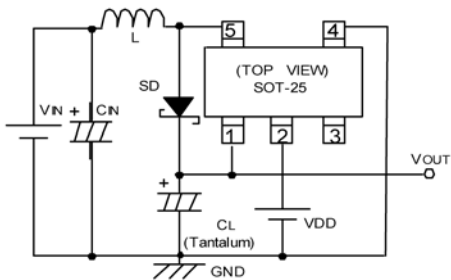
- L: 100 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)

D type circuit



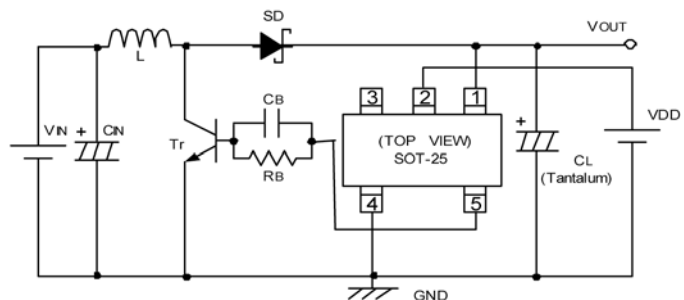
- L: 47 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)
- RB: 500
- CB: 2200pF
- Tr: 2SD1628 (SANYO)

E type circuit



- L: 100 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)

F type circuit



- L: 47 μ H (Coil, CR54, SUMIDA)
- SD: XB01SB04A2BR (Schottky type, TOREX)
- CL: 16V, 47 μ F (Tantalum)
- CIN: 16V, 47 μ F (Tantalum)
- RB: 1k
- CB: 3300pF
- Tr: 2SD1628 (SANYO)

OPERATIONAL EXPLANATION

The XC9110/9111 series are PFM controlled step-up DC/DC converter (A, C and E types) / controller ICs (B, D and F types), which contain voltage reference source, PFM comparator, duty selector, PFM controlled OSC, VLx Limiter, driver transistor and so on. With the XC9110 series, maximum duty ratio is set to 75% (maximum oscillation frequency=MAXFOOSC: 100kHz) making it suitable for use with large current operations. The XC9111 series automatically switches duty ratio between 56% (MAXFOOSC: 180kHz) and 75% (MAXFOOSC: 100kHz) when it senses changes in load and can support both large and small currents.

<Reference Voltage Source (Vref) >

The reference voltage source provides the reference voltage to ensure stable output voltage of the DC/DC converter.

< PFM Comparator >

The PFM comparator compares the feedback voltage divided by the internal split resistors with the internal reference voltage. When the feedback voltage is higher than the reference voltage, PFM controlled OSC will be stopped. When the feedback voltage is lower than the reference voltage, the PFM controlled OSC will be operated so that the output voltage will be stable by sending a signal to the buffer drive circuit and controlling the internal or external driver transistor.

< Duty Selector >

With the XC9111 series, the duty selector automatically switches duty ratio between 56% and 75% when it senses changes in load and can support both large and small currents.

< PFM Controlled Oscillator >

The PFM controlled OSC determines maximum oscillation frequency. The circuit generates the oscillation frequency of 100kHz at 75% duty and 180kHz at 56%.

< VLx Limiter>

The VLx circuit of the XC9110/9111 A, C and D types detects in-rush current and overcurrent, which flows from the VOUT pin to the Lx pin during short-circuit. In overcurrent, the driver transistor will be OFF. When the overcurrent state is eliminated, the IC resumes its normal operation.

<Chip Enable Function>

The chip enable function of the XC9110/9111 C and D types enables the IC to be in shut down mode when a low level signal is input to the CE pin. During the shut down mode, the current consumption will be reduced to 0.5 μ A (MAX.).

<Separated VDD/VOUT>

With the separated VDD pin, the XC9110/9111 E and F types can be operated in both low and high voltage.

EXTERNAL COMPONENTS

Tr.: *Using a MOSFET

XP151A13A0MR (N-ch Power MOSFET, TOREX)

Note : V_{GS} breakdown voltage of this Transistor is 8V so please be careful with the power supply voltage.

If the power supply voltage is over 6V, Please use the XP151A12A2MR with a V_{GS} breakdown voltage of 12V.

* Using a NPN Transistor

2SD1628 (SANYO)

R_B: 500 (Adjust in accordance with load and Tr's hFE.)

C_B: 2200pF (Ceramic)

$C_B = 1 / (2TT \times R_B \times FOSC \times 0.7)$

R_B value example (when using NPN Transistor)

V _{OUT} (V)	I _{OUT} (mA)	V _{IN} (V)	R _B ()	V _{OUT} (V)	I _{OUT} (mA)	V _{IN} (V)	R _B ()
1.8	10	1.2	4.5	3.3	5	1.2	6.5
1.8	10	1.5	6.0	3.3	5	1.5	6.5
1.8	30	1.2	2.0	3.3	10	1.2	5.0
1.8	30	1.5	2.0	3.3	10	1.5	4.5
1.8	50	1.2	1.2	3.3	30	1.2	3.5
1.8	50	1.5	1.5	3.3	30	1.5	3.5

* Tr.: 2SD1628

SD: XP01SB04A2BR (TOREX)
MA2Q735 (MATSUSHITA)

CL: 16V, 47 μF (Tantalum type, KYOCERA TAJ)

C_{IN}: 16V, 47 μF (Tantalum type, KYOCERA TAJ)

16V, 220 μF (Electrolytic Capacitor)

L: <XC9110/9111A, C and E series (Transistor built-in)>

100 μH (CR54,SUMIDA)

100 μH (CDRH6D28,SUMIDA)

<XC9110/9111B, D and F series(Transistor external)>

22 μH, 47 μH

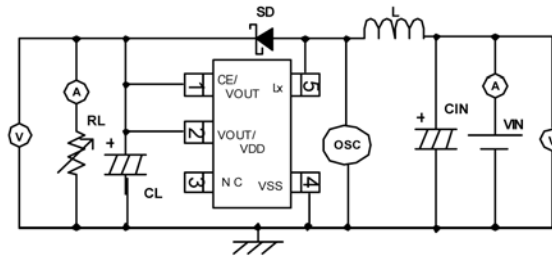
(CR54, SUMIDA)

NOTES ON USE

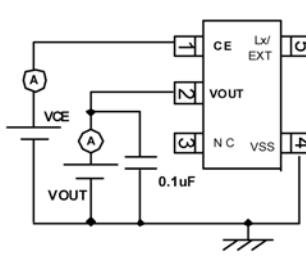
1. Please do not exceed the value of stated absolute maximum ratings.
2. The DC/DC converter / controller IC's performance is greatly influenced by not only the ICs' characteristics, but also by those of the external components. Care must be taken when selecting the external components.
3. The Lx limit voltage function becomes stable when V_{OUT} of the XC9110/9111C series is over 2.0V and the V_{DD} of the XC9110/9111E series is over 2.0V.
4. Make sure that the PCB GND traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
5. Please mount each external component as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.

TEST CIRCUITS

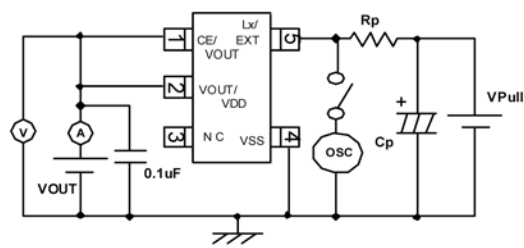
Circuit



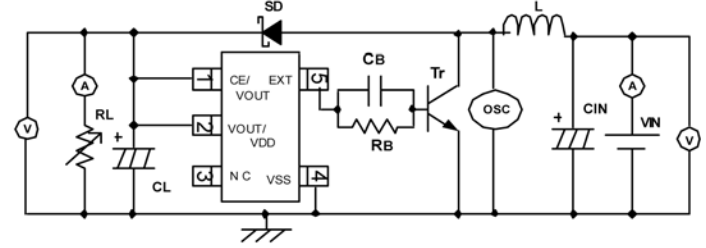
Circuit



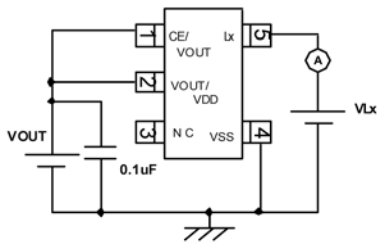
Circuit



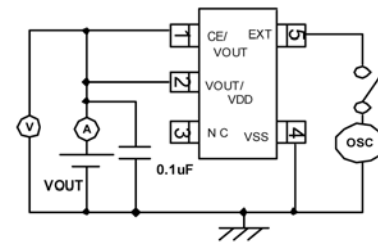
Circuit



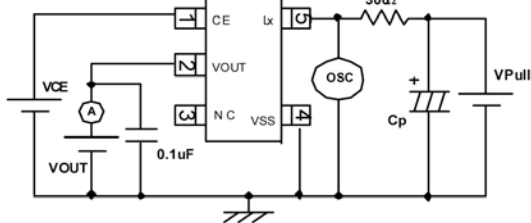
Circuit



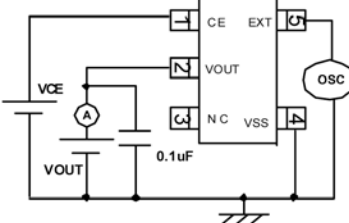
Circuit



Circuit



Circuit



<External Components>

Circuit

CIN: 47 μ F, 16V (Tantalum)
L: CR54, 100 μ H (SUMIDA)
SD: XB01SB04A2BR (Schottky, TOREX)
CL: 47 μ F, 16V (Tantalum)

Circuit

Cp: 100 μ F (OS-CON, SANYO)

Circuit

Rp: 300
Rp: 10 (For Lx ON Resistance and measuring Lx Limit Current)
Rp: 200 (For measuring EXT ON Resistance)
Cp: 100 μ F (OS-CON, SANYO)

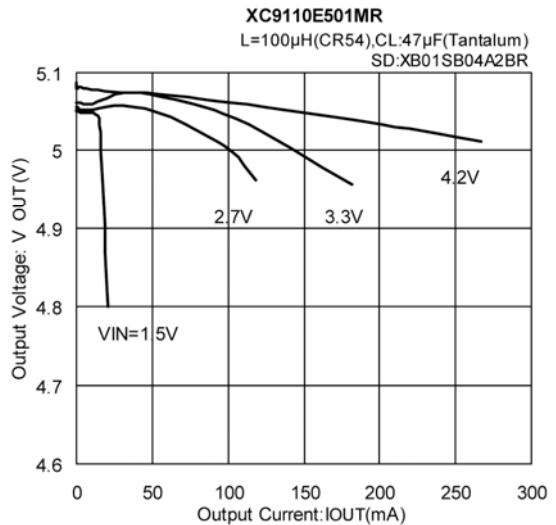
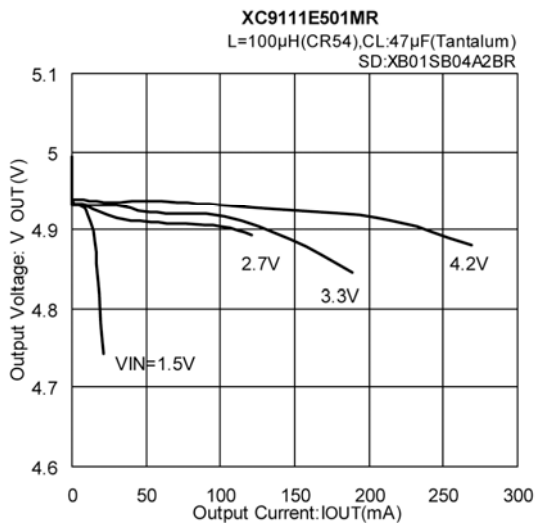
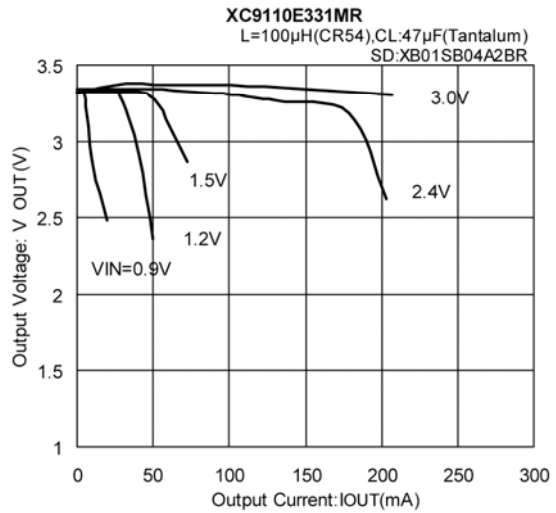
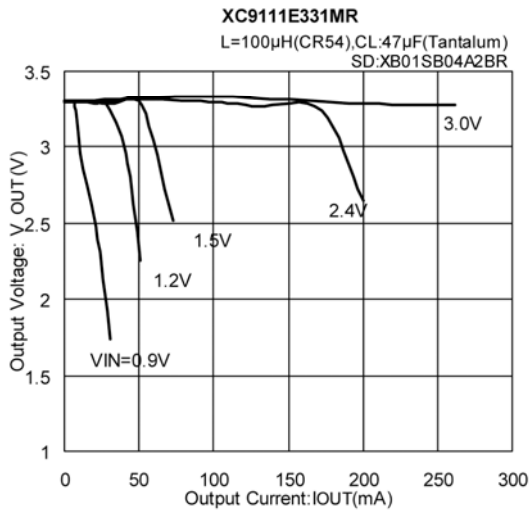
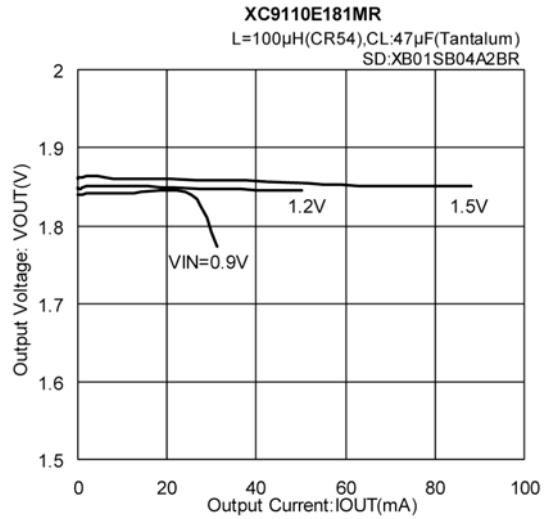
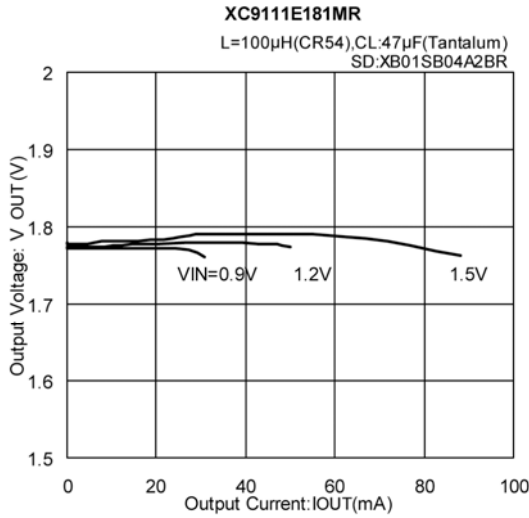
Circuit

CIN: 47 μ F, 16V (Tantalum)
L: CR54, 100 μ H (SUMIDA)
Tr: 2SD1628 (SANYO)
CB: 2200pF
RB: 500
SD: XB01SB04A2BR (Schottky, TOREX)
CL: 47 μ F, 16V (Tantalum)

TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

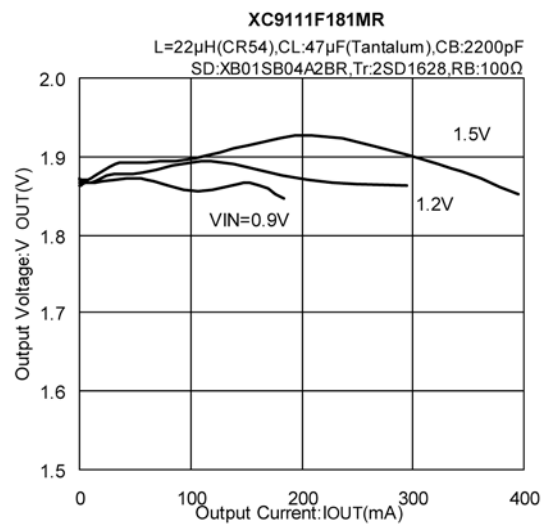
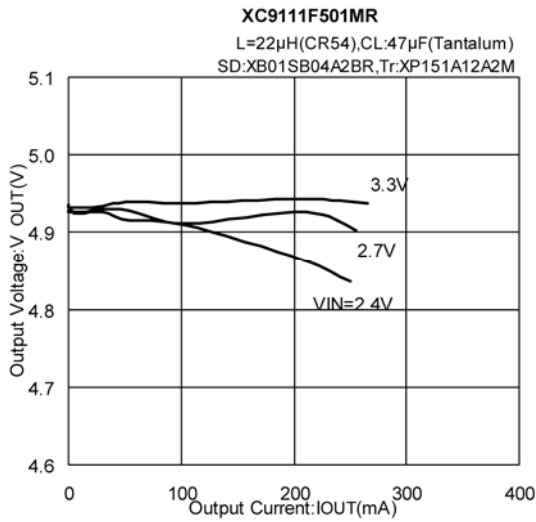
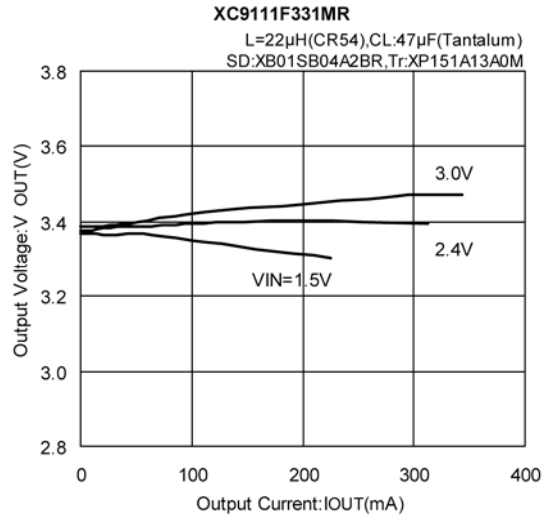
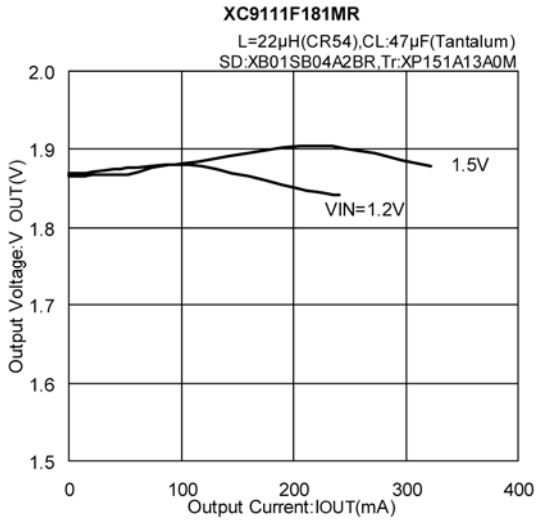
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(1) Output Voltage vs. Output Current (Continued)

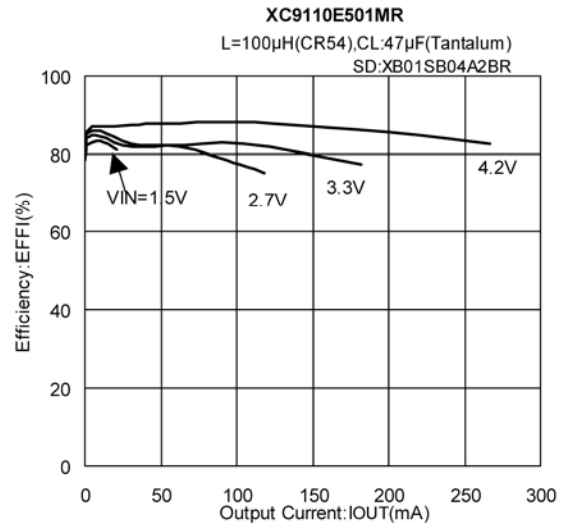
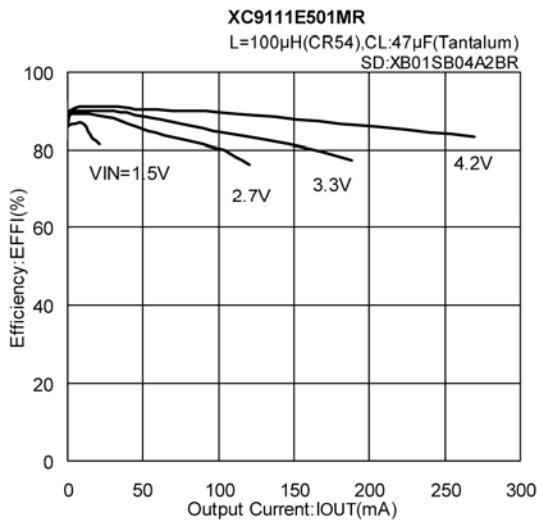
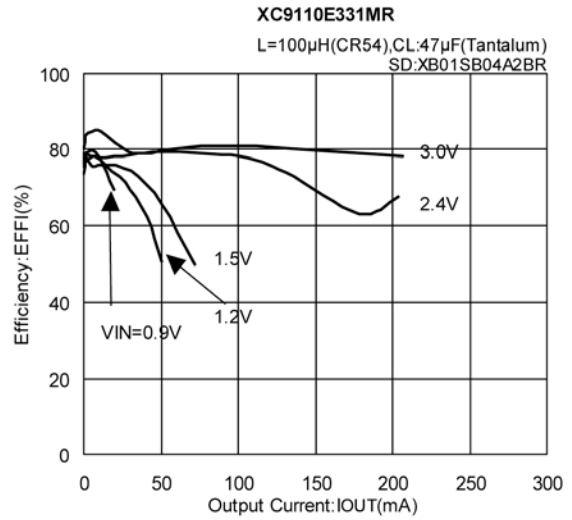
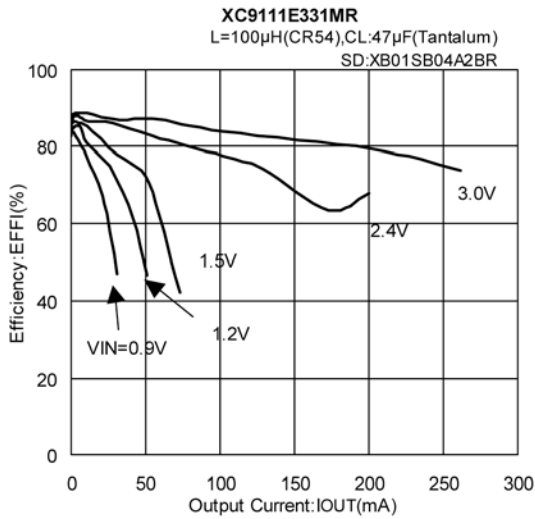
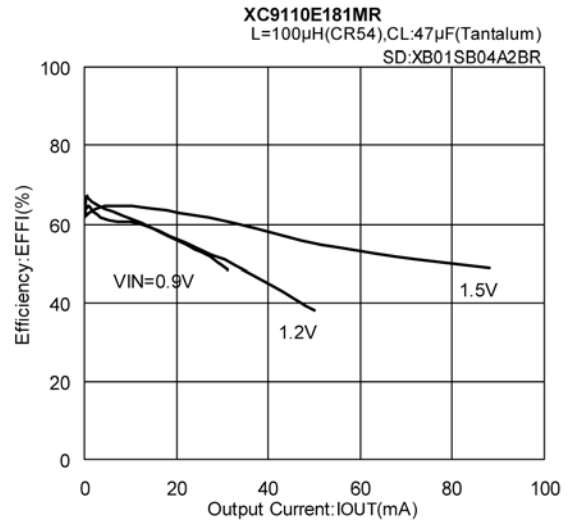
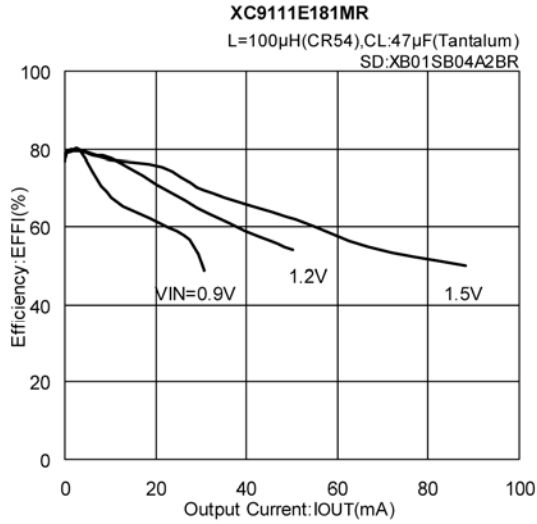
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Efficiency vs. Output Current

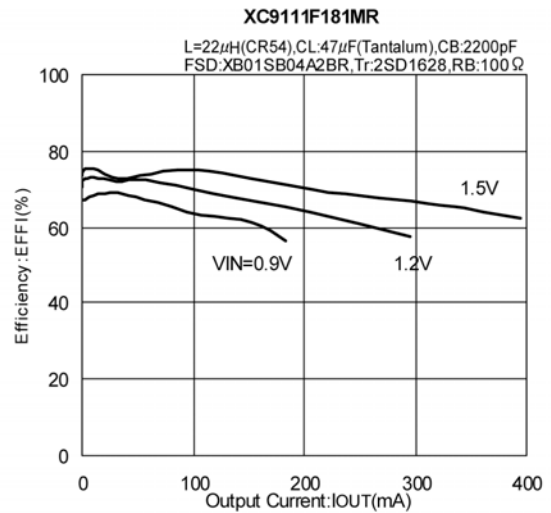
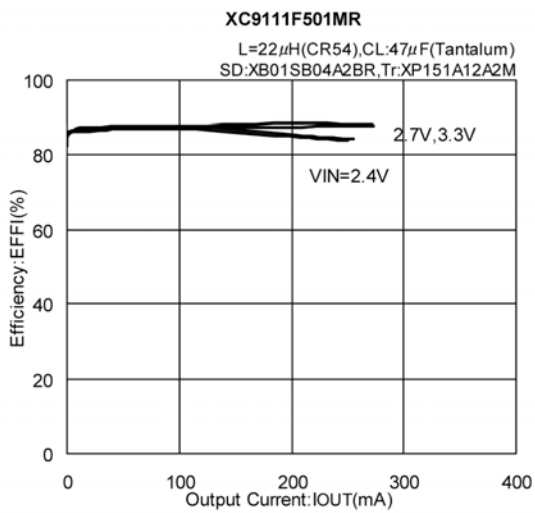
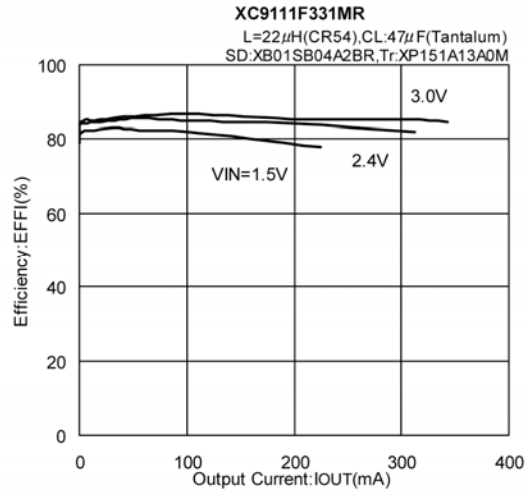
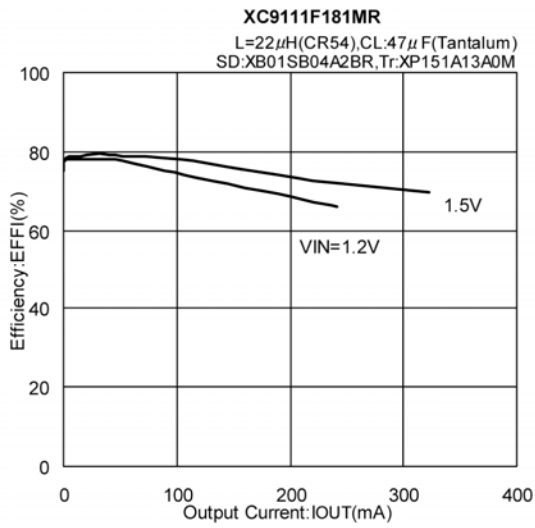
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Efficiency vs. Output Current (Continued)

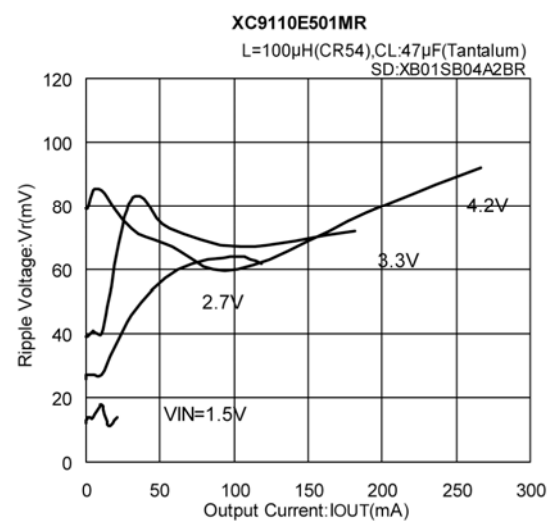
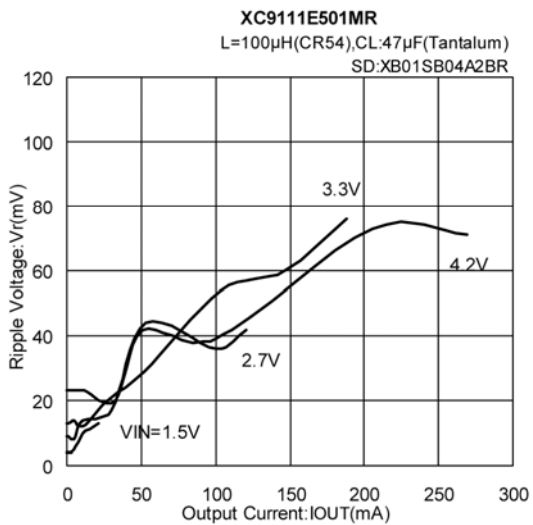
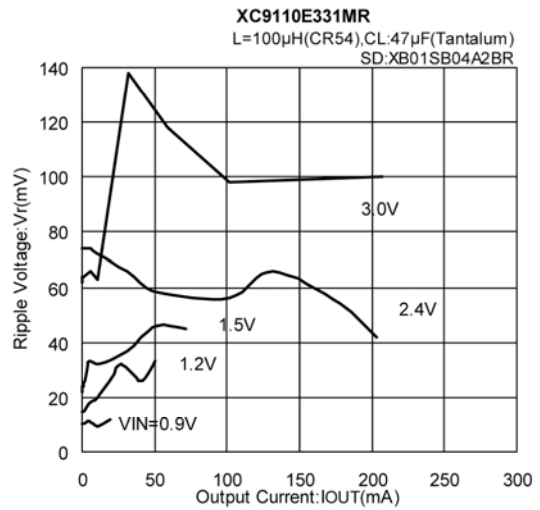
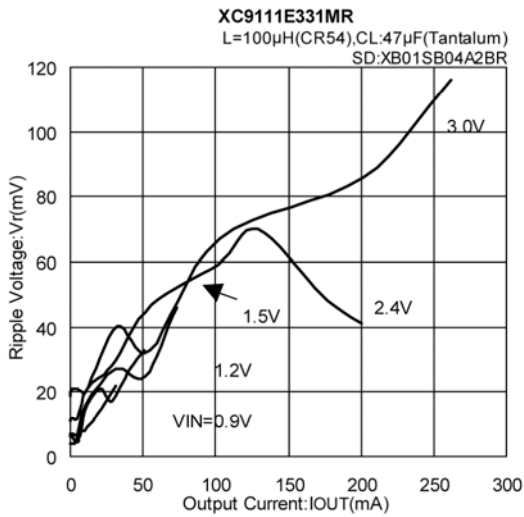
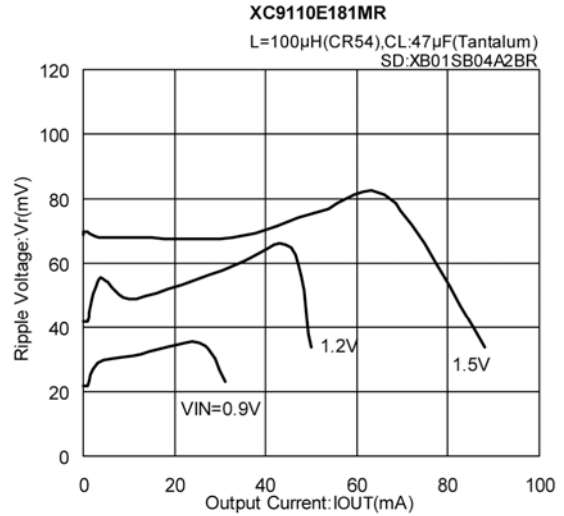
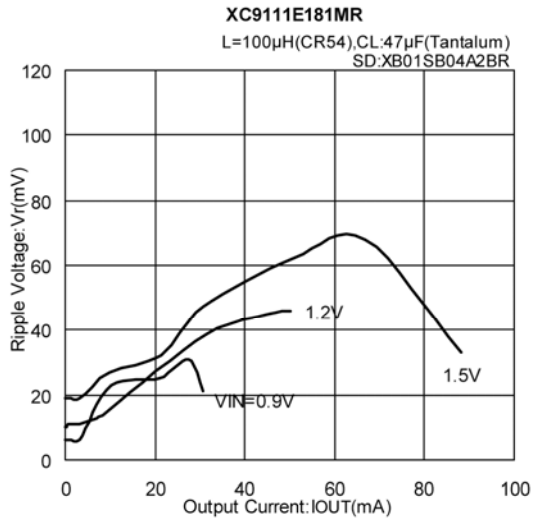
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Ripple Voltage vs. Output Current

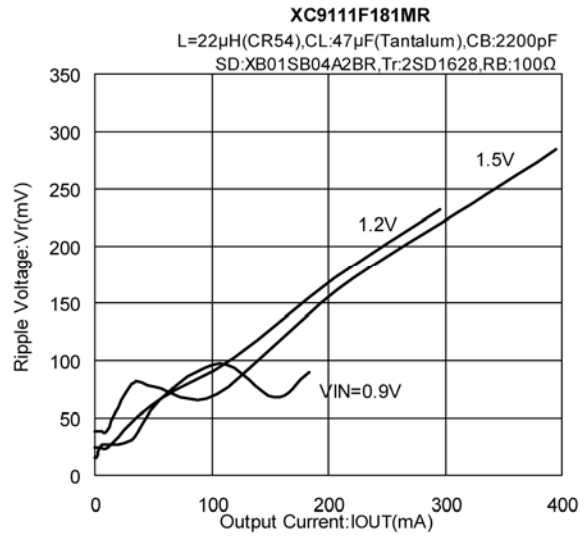
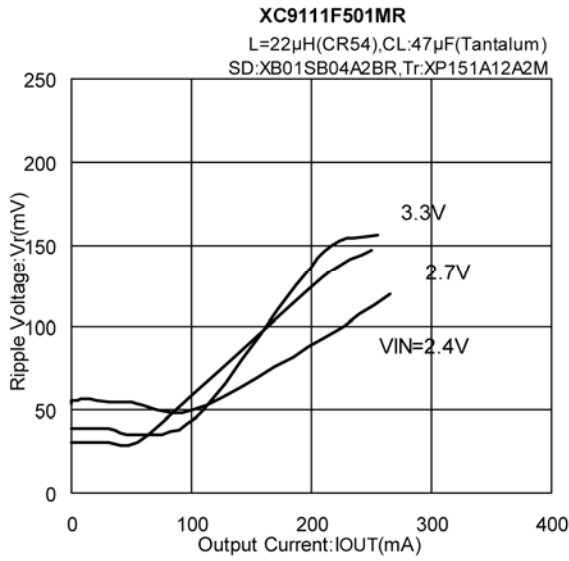
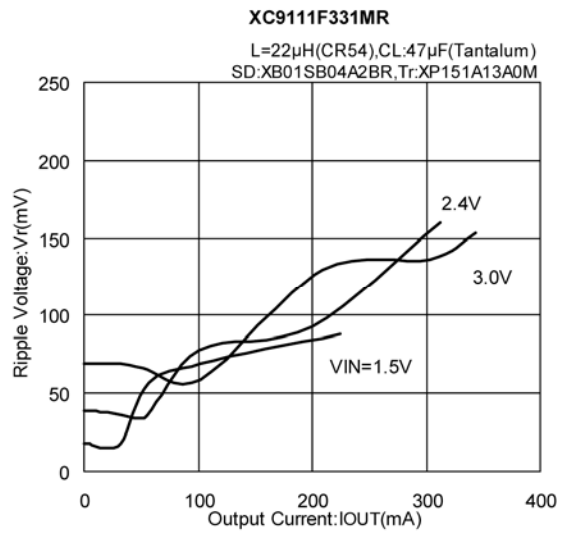
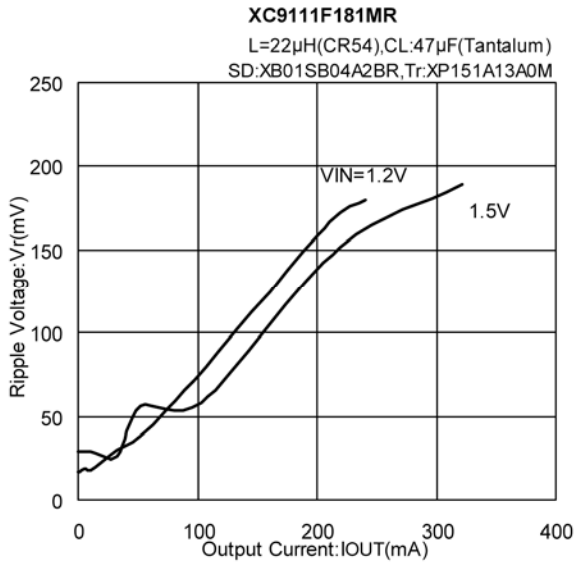
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Ripple Voltage vs. Output Current (Continued)

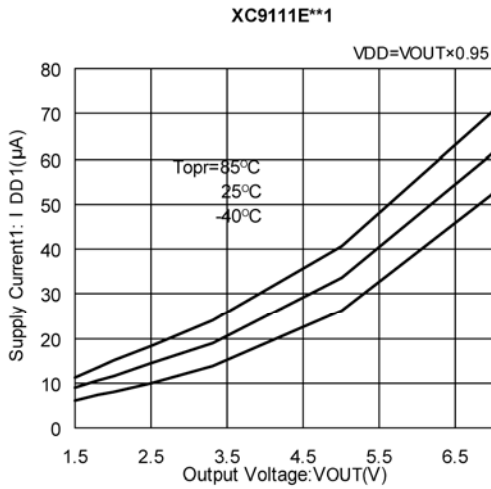
*Topr = 25



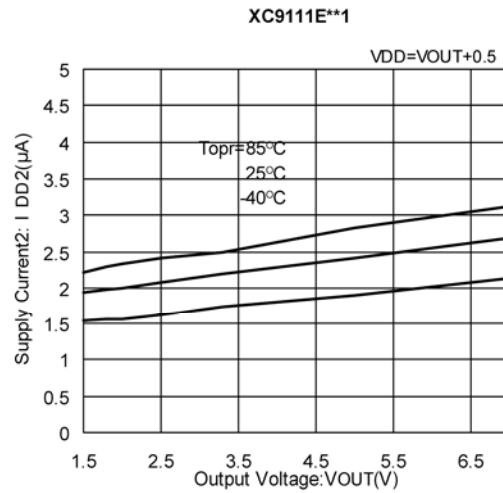
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

*Topr = 25

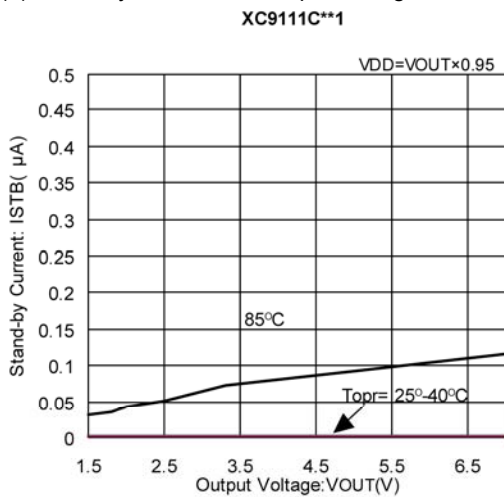
(4) Supply Current 1 vs. Output Voltage



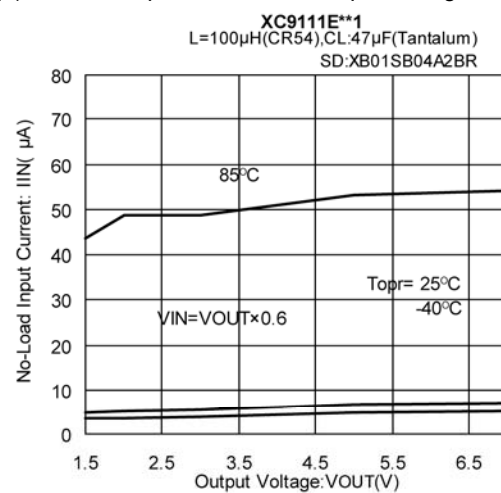
(5) Supply Current 2 vs. Output Voltage



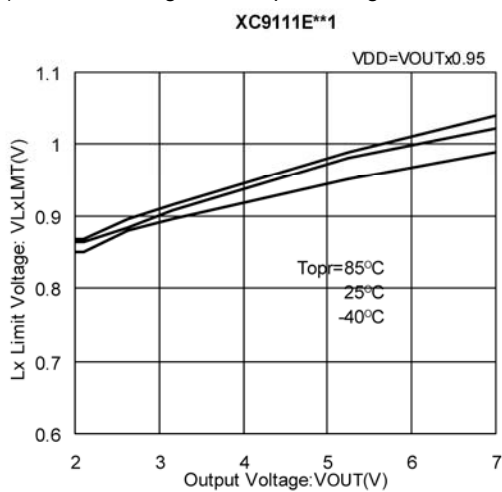
(6) Stand-by Current vs. Output Voltage



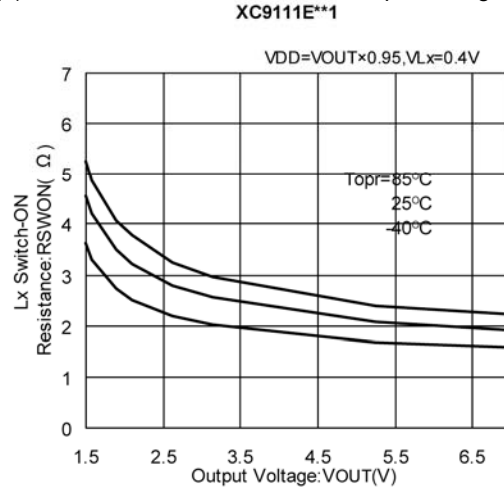
(7) No Load Input Current vs. Output Voltage



(8) Lx Limit Voltage vs. Output Voltage



(9) Lx Switch-ON Resistance vs. Output Voltage

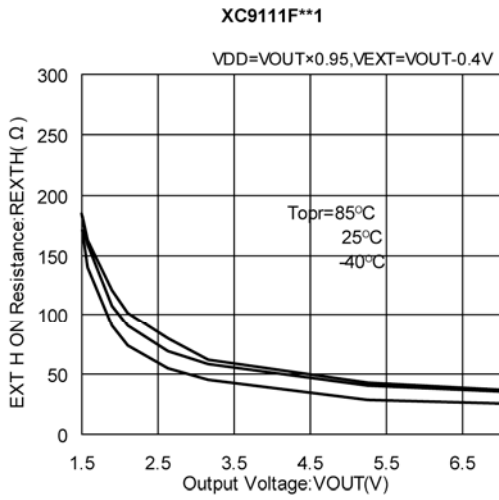


* The reason for the increase in the "no load input current" figure at Ta=85 in the performance characteristics is because of an increase in the reverse current of the Schottky diode and not because of abnormalities of the IC itself.

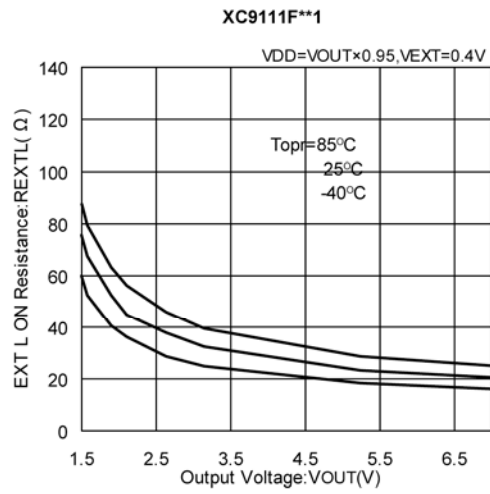
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

*Topr = 25

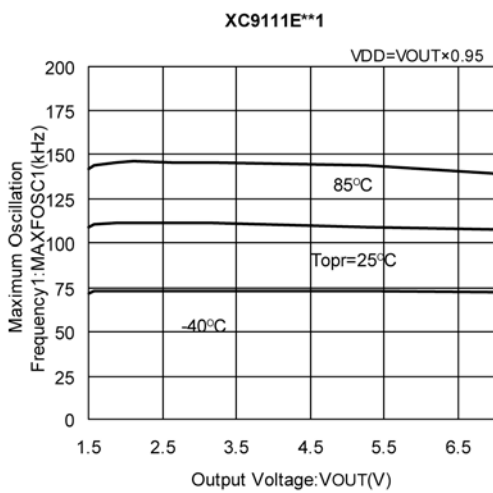
(10) EXT H ON Resistance vs. Output Voltage



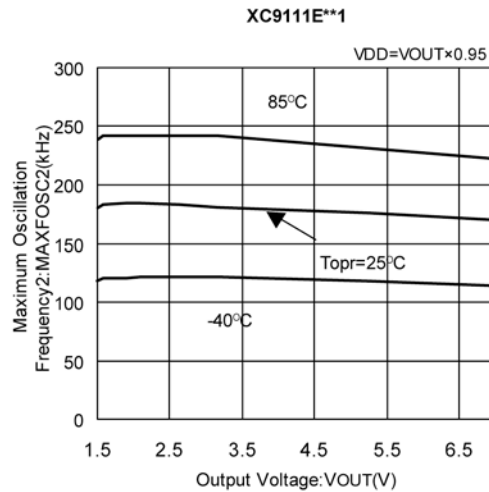
(11) EXT L ON Resistance vs. Output Voltage



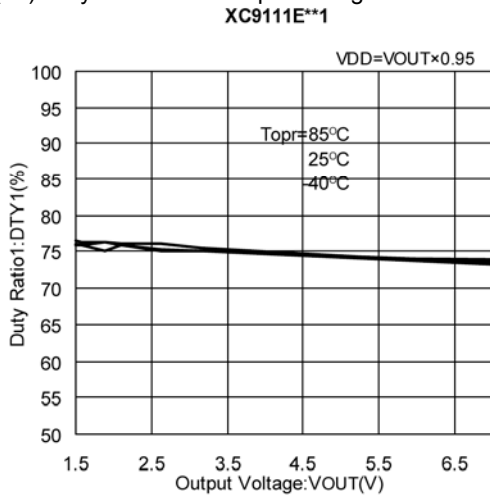
(12) Maximum Oscillation Frequency 1 vs. Output Voltage



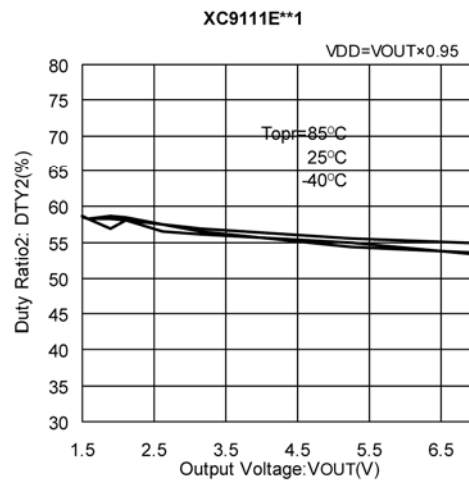
(13) Maximum Oscillation Frequency 2 vs. Output Voltage



(14) Duty Ratio 1 vs. Output Voltage



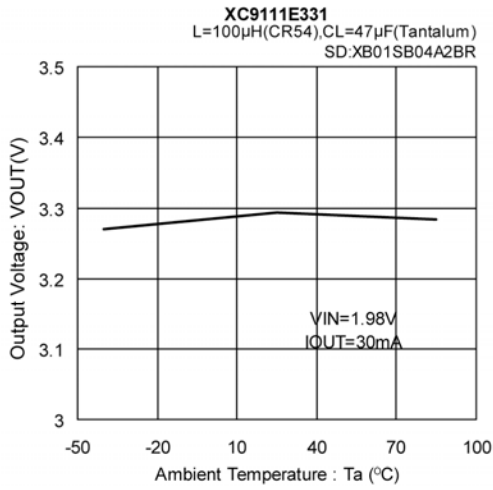
(15) Duty Ratio 2 vs. Output Voltage



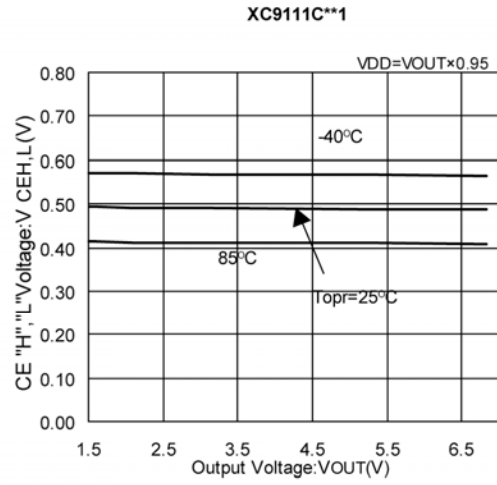
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

*Topr = 25

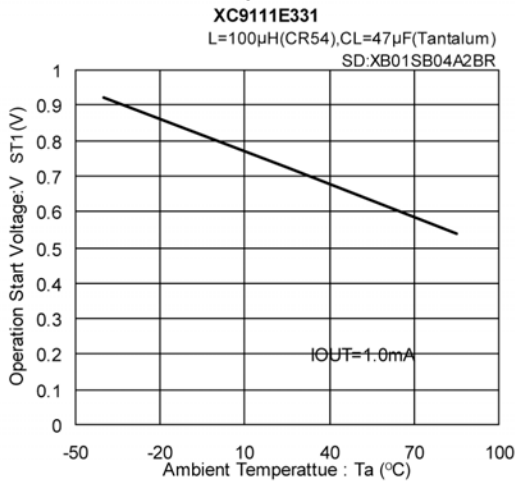
(16) Output Voltage vs. Ambient Temperature



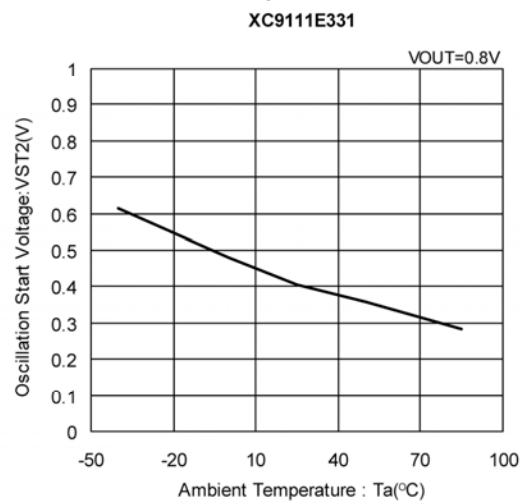
(17) CE "H", "L" Voltage vs. Output Voltage



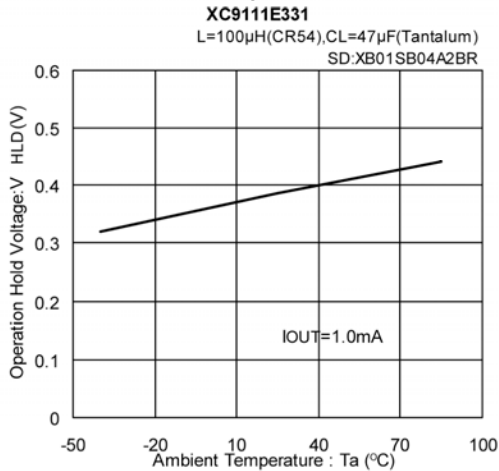
(18) Operation Start Voltage vs. Ambient Temperature



(19) Oscillation Start Voltage vs. Ambient Temperature



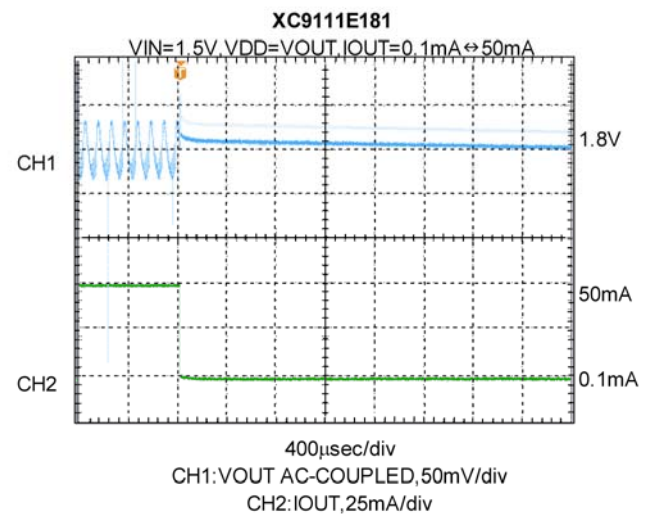
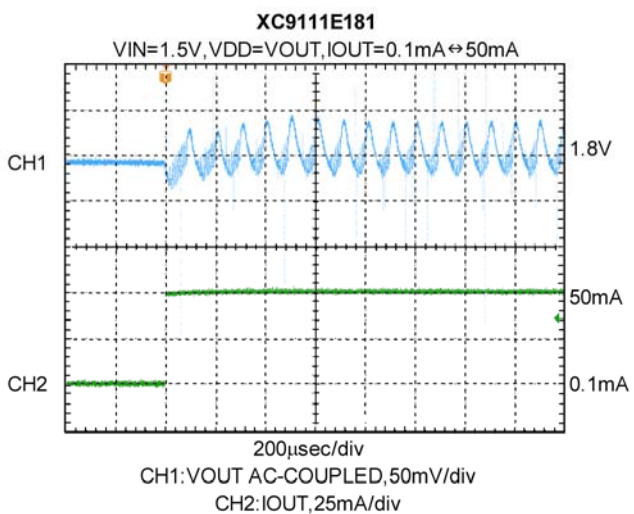
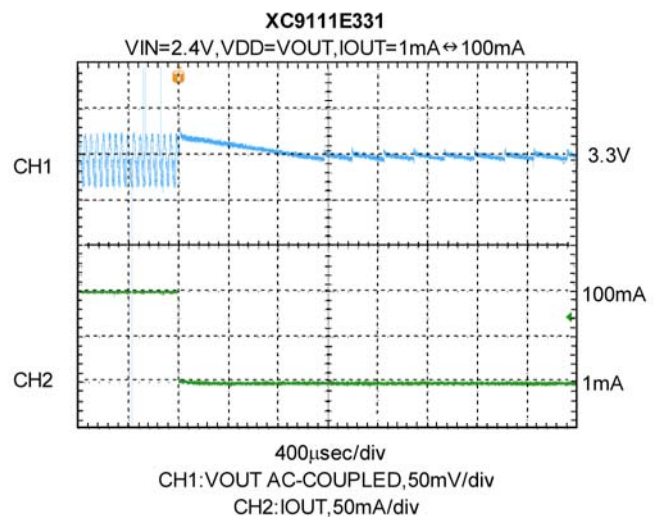
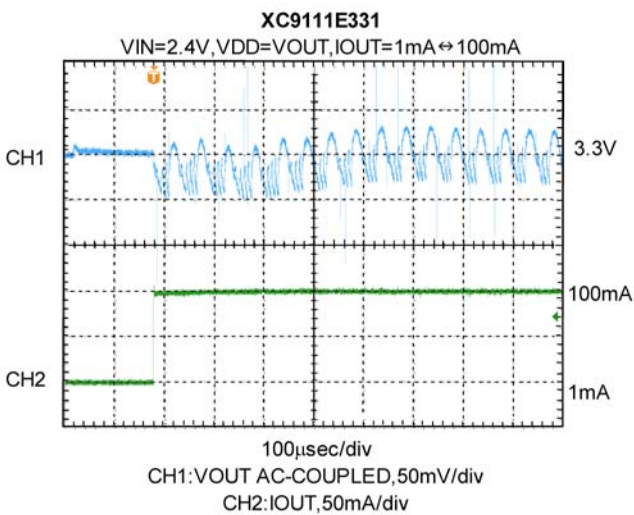
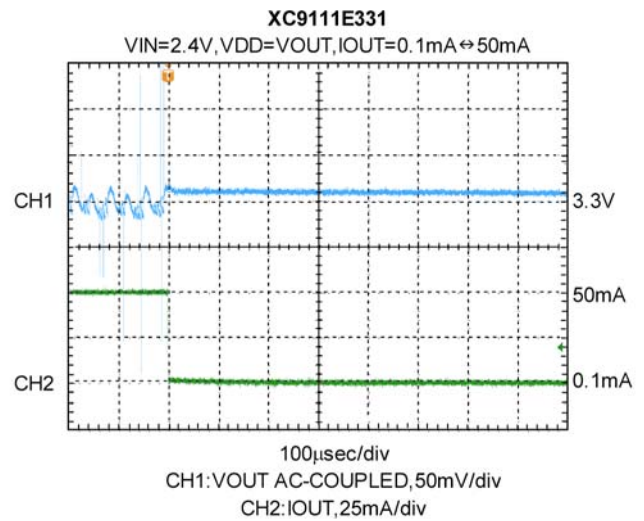
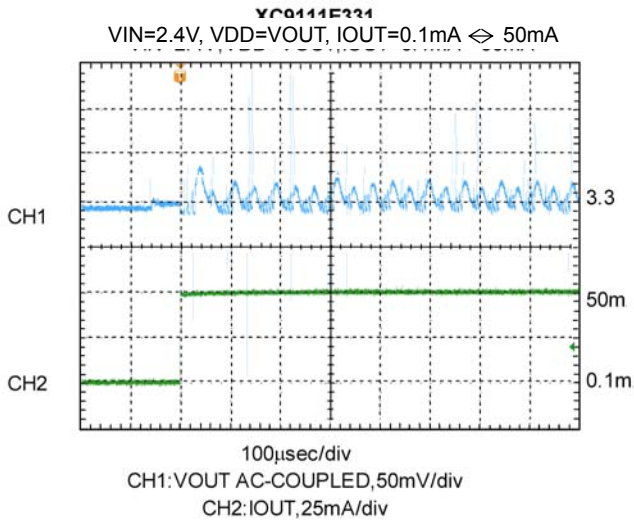
(20) Operation Hold Voltage vs. Ambient Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(21) Load Transient Response

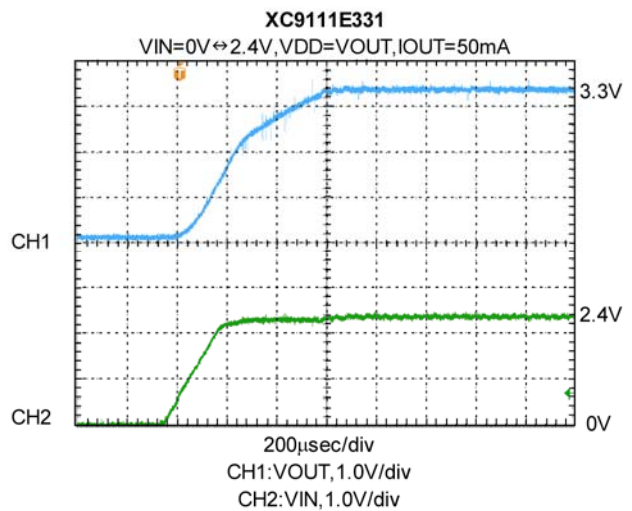
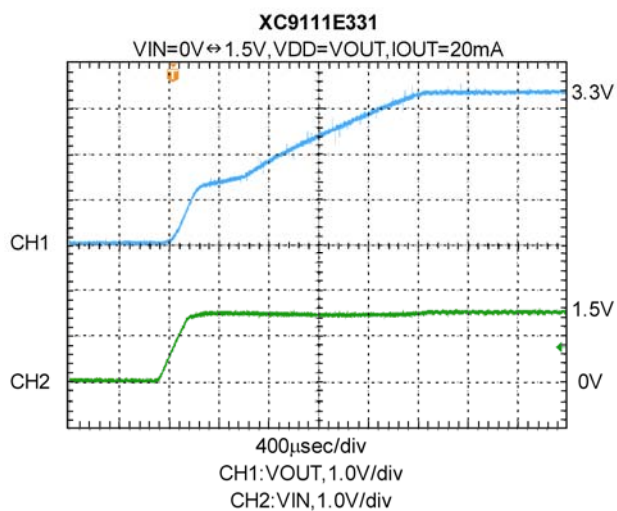
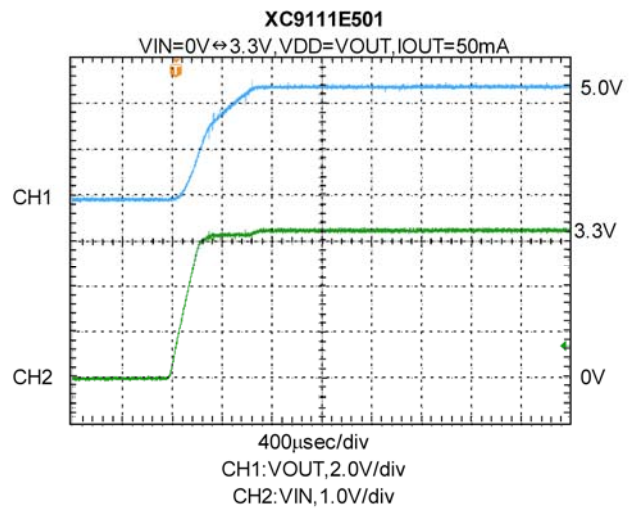
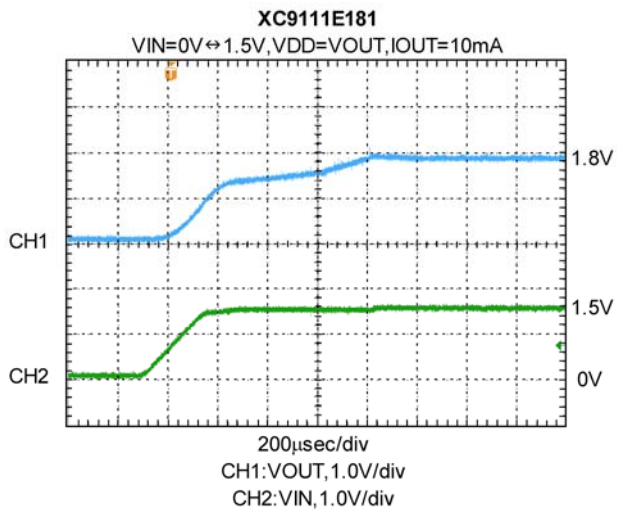
*Topr = 25



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

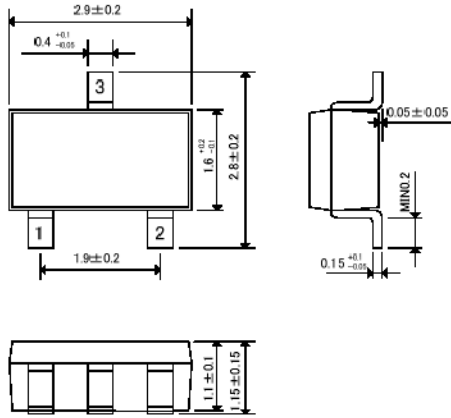
(22) Input Transient Response

*Topr = 25

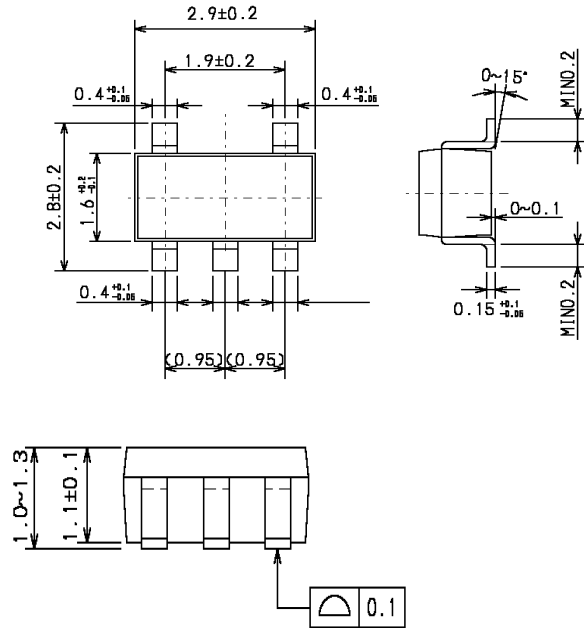


PACKAGING INFORMATION

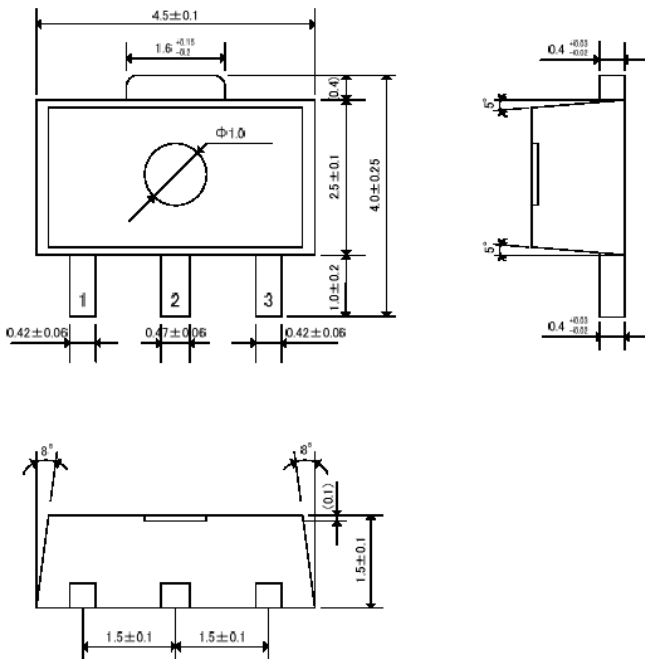
SOT-23



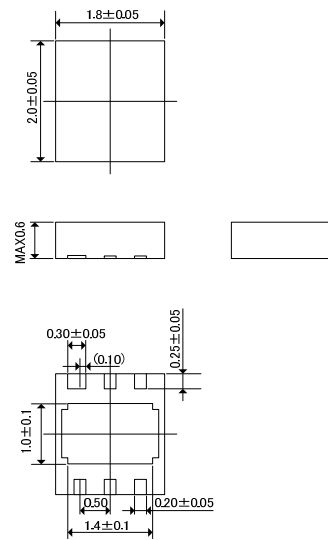
SOT-25 (SOT-23-5)



SOT-89



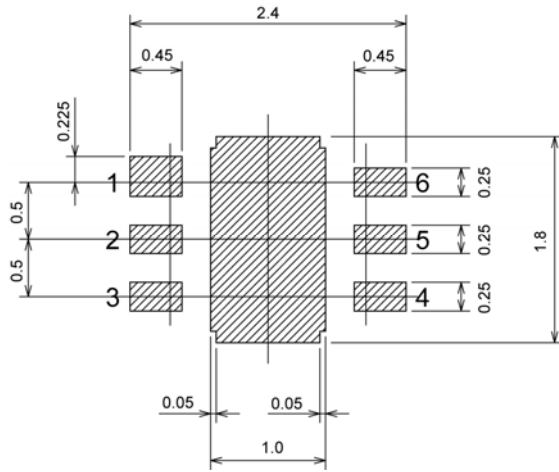
USP-6C



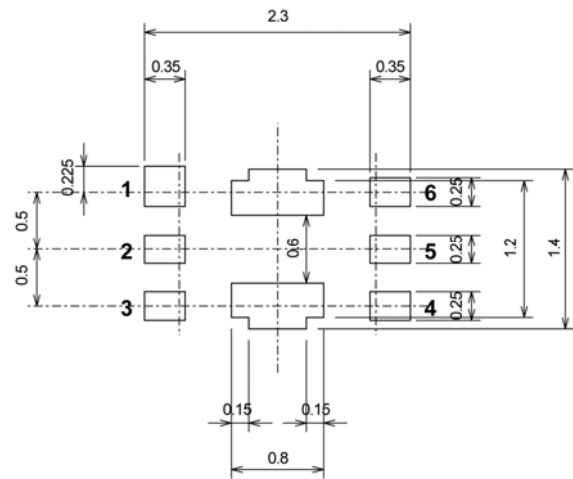
USP-6C Package

PACKAGING INFORMATION (Continued)

USP-6C Reference Pattern Layout

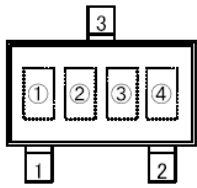


USP-6C Reference Metal Mask Design



MARKING RULE

SOT-23



SOT-23 (TOP VIEW)

Represents product series

MARK	FUNCTIONS	PRODUCT SERIES
5	-	Built-In Transistor
6	-	External Transistor

Represents integer of output voltage and oscillation frequency

OUTPUT VOLTAGE	MARK
	FOSC=100kHz
1.x	1
2.x	2
3.x	3
4.x	4
5.x	5
6.x	6
7.x	7

Represents decimal point of output voltage and oscillation frequency

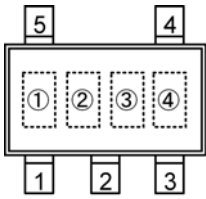
OUTPUT VOLTAGE	MARK
	FOSC=100kHz
x.0	0
x.1	1
x.2	2
x.3	3
x.4	4
x.5	5
x.6	6
x.7	7
x.8	8
x.9	9

Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

MARKING RULE (Continued)

SOT-25



SOT-25 (TOP VIEW)

Represents product series

MARK	FUNCTION		PRODUCT SERIES
<u>V</u>	CE	Tr. Built-in	XC9110Cxxxxx
<u>X</u>	CE	External Tr.	XC9110Dxxxxx
<u>Y</u>	VDD/VOUT	Tr. Built-in	XC9110Exxxxx
<u>Z</u>	VDD/VOUT	External Tr.	XC9110Fxxxxx
5	CE	Tr. Built-in	XC9111Cxxxxx
6	CE	External Tr.	XC9111Dxxxxx
7	VDD/VOUT	Tr. Built-in	XC9111Exxxxx
8	VDD/VOUT	External Tr.	XC9111Fxxxxx

Represents integer of output voltage and oscillation frequency

OUTPUT VOLTAGE	MARK
	FOSC=100kHz
1.x	1
2.x	2
3.x	3
4.x	4
5.x	5
6.x	6
7.x	7

Represents decimal point of output voltage and oscillation frequency

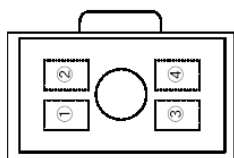
OUTPUT VOLTAGE	MARK
	FOSC=100kHz
x.0	0
x.1	1
x.2	2
x.3	3
x.4	4
x.5	5
x.6	6
x.7	7
x.8	8
x.9	9

Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

MARKING RULE (Continued)

SOT-89



SOT-89 (TOP VIEW)

Represents product series

MARK	FUNCTIONS		PRODUCT SERIES
5	-	Built-In Transistor	XC9111Axxxxx
6	-	External Transistor	XC9111Bxxxxx

Represents integer of output voltage and oscillation frequency

OUTPUT VOLTAGE	MARK	
	FOOSC 100kHz	
1.x	1	
2.x	2	
3.x	3	
4.x	4	
5.x	5	
6.x	6	
7.x	7	

Represents decimal point of output voltage and oscillation frequency

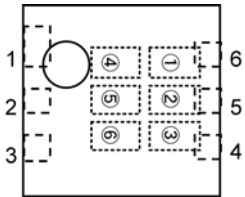
OUTPUT VOLTAGE	MARK	
	FOOSC 100kHz	
x.0	0	
x.1	1	
x.2	2	
x.3	3	
x.4	4	
x.5	5	
x.6	6	
x.7	7	
x.8	8	
x.9	9	

Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

MARKING RULE (Continued)

USP-6C



USP-6C (TOP VIEW)

Represents product series

MARK	PRODUCT SERIES
M	XC9110xxx1Dx
N	XC9111xxx1Dx

Represents series type

MARK	FUNCTION	PRODUCT SERIES
C	CE Tr. Built-in	XC911xCxx1Dx
D	CE External Tr.	XC911xDxx1Dx
E	VDD/VOUT Tr. Built-in	XC911xExx1Dx
F	VDD/VOUT External Tr.	XC911xFxx1Dx

Represents integer of output voltage

MARK	OUTPUT VOLTAGE
1	1.x
2	2.x
3	3.x
4	4.x
5	5.x
6	6.x
7	7.x

Represents decimal point of output voltage

MARK	OUTPUT VOLTAGE
0	x.0
1	x.1
2	x.2
3	x.3
4	x.4
5	x.5
6	x.6
7	x.7
8	x.8
9	x.9

Represents oscillation frequency

MARK	OSCILLATION FREQUENCY	PRODUCT SERIES
1	x.0	XC911xxxx1Dx

Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

* No character inversion used

1. The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
2. We assume no responsibility for any infringement of patents, patent rights, or other rights arising from the use of any information and circuitry in this datasheet.
3. Please ensure suitable shipping controls (including fail-safe designs and aging protection) are in force for equipment employing products listed in this datasheet.
4. The products in this datasheet are not developed, designed, or approved for use with such equipment whose failure or malfunction can be reasonably expected to directly endanger the life of, or cause significant injury to, the user.
(e.g. Atomic energy; aerospace; transport; combustion and associated safety equipment thereof.)
5. Please use the products listed in this datasheet within the specified ranges.
Should you wish to use the products under conditions exceeding the specifications, please consult us or our representatives.
6. We assume no responsibility for damage or loss due to abnormal use.
7. All rights reserved. No part of this datasheet may be copied or reproduced without the prior permission of TOREX SEMICONDUCTOR LTD.

TOREX SEMICONDUCTOR LTD.